P&S Processing-in-Memory

Exploring the Processing-in-Memory Paradigm for Future Computing Systems

Dr. Juan Gómez Luna Prof. Onur Mutlu ETH Zürich Spring 2022 10 March 2022

P&S: Processing-in-Memory (I)

227-0085-37L Projects & Seminars: Exploring the Processing-in-Memory Paradigm for Future Computing Systems

Semester		Spring Semester 2022																
Lecturers Periodicity Language of instruction Comment		every semester recurring course English Only for Electrical Engineering and Information Technology BSc. The course unit can only be taken once. Repeated enrollment in a later semester is not creditable.																
									Courses	Catalogue data	Performance assessment	Learning materials	Groups	Restrictions	Offered in	> Overview		
									Abstract		The category of "Laboratory Courses, Projects, Seminars" includes courses and laboratories in various formats designed to impart practical knowledge and skills. Moreover, these classes encourage independent experimentation and design, allow for explorative learning and teach the methodology of project work.							
									Objective		Data movement between the memory units and the compute units of current computing systems is a major performance and energy bottleneck. From large-scale servers to mobile devices, data movement costs dominate computation costs in terms of both performance and energy consumption. For example, data movement between the main memory and the processing cores accounts for 62% of the total system energy in consumer applications. As a result, the data movement bottleneck is a huge burden that greatly limits the energy efficiency and performance of modern computing systems. This phenomenon is an undesired effect of the dichotomy between memory and the processor, which leads to the data movement bottleneck.							
		time data analytics suffer great data reuse, low cache line uti main memory size. The comp movement bottleneck, we nee	atly from the data mover ilzation, low arithmetic in utation in these workloa ed a paradigm shift from design where processing	nent bottlene itensity (i.e., ds cannot us the tradition	eck. These worklo ratio of operation sually compensate al processor-cent	pads are exemp as per accessed e for the data m tric design, whe	lified by irregular byte), and large novement costs. In re all computation											

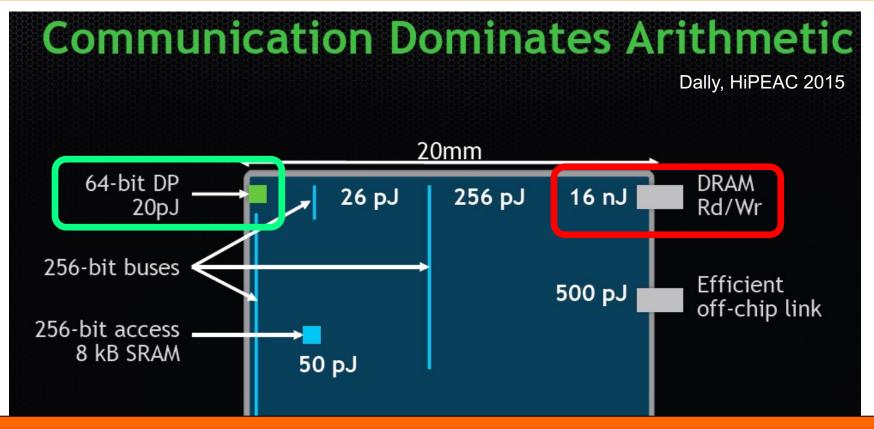
P&S: Processing-in-Memory (II)

Data movement between the memory units and the compute units of current computing systems is a major performance and energy bottleneck. From large-scale servers to mobile devices, data movement costs dominate computation costs in terms of both performance and energy consumption. For example, data movement between the main memory and the processing cores accounts for 62% of the total system energy in consumer applications. As a result, the data movement bottleneck is a huge burden that greatly limits the energy efficiency and performance of modern computing systems. This phenomenon is an undesired effect of the dichotomy between memory and the processor, which leads to the data movement bottleneck.

Many modern and important workloads such as machine learning, computational biology, graph processing, databases, video analytics, and real-time data analytics suffer greatly from the data movement bottleneck. These workloads are exemplified by irregular memory accesses, relatively low data reuse, low cache line utilization, low arithmetic intensity (i.e., ratio of operations per accessed byte), and large datasets that greatly exceed the main memory size. The computation in these workloads cannot usually compensate for the data movement costs. In order to alleviate this data movement bottleneck, we need a paradigm shift from the traditional processor-centric design, where all computation takes place in the compute units, to a more data centric design where processing elements are placed closer to or inside where the data resides. This paradigm of computing is known as Processing-in Memory (PIM).

This is your perfect P&S if you want to become familiar with the main PIM technologies, which represent "the next big thing" in Computer Architecture. You will work hands-on with the first real-world PIM architecture, will explore different PIM architecture designs for important workloads, and will develop tools to enable research of future PIM systems. Projects in this course span software and hardware as well as the software/hardware interface. You can potentially work on developing and optimizing new workloads for the first real world PIM hardware or explore new PIM designs in simulators, or do something else that can forward our understanding of the PIM paradigm.

Data Movement vs. Computation Energy



A memory access consumes ~1000X the energy of a complex addition

Goals of this P&S Course

P&S Processing-in-Memory: Contents

- We will introduce the data movement bottleneck, which is a major threat to high performance and energy efficiency of current computing systems
- You will learn what are key workload characteristics that make them more prone to the data movement bottleneck
- You will review traditional approaches to alleviating data movement and will get familiar with new research proposals: processing-in-memory solutions
- You will work hands-on: analyzing workloads, programming PIM architectures, simulating new PIM proposals, etc.

A +50-Year-Old Paradigm

Kautz, "Cellular Logic-in-Memory Arrays", IEEE TC 1969

IEEE TRANSACTIONS ON COMPUTERS, VOL. C-18, NO. 8, AUGUST 1969

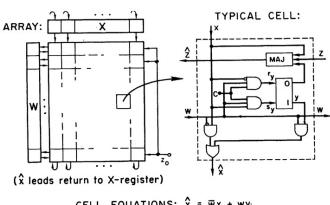
Cellular Logic-in-Memory Arrays

WILLIAM H. KAUTZ, MEMBER, IEEE

Abstract—As a direct consequence of large-scale integration, many advantages in the design, fabrication, testing, and use of digital circuitry can be achieved if the circuits can be arranged in a two-dimensional iterative, or cellular, array of identical elementary networks, or cells. When a small amount of storage is included in each cell, the same array may be regarded either as a logically enhanced memory array, or as a logic array whose elementary gates and connections can be "programmed" to realize a desired logical behavior.

In this paper the specific engineering features of such cellular logic-in-memory (CLIM) arrays are discussed, and one such special-purpose array, a cellular sorting array, is described in detail to illustrate how these features may be achieved in a particular design. It is shown how the cellular sorting array can be employed as a single-address, multiword memory that keeps in order all words stored within it. It can also be used as a content-addressed memory, a pushdown memory, a buffer memory, and (with a lower logical efficiency) a programmable array for the realization of arbitrary switching functions. A second version of a sorting array, operating on a different sorting principle, is also described.

Index Terms—Cellular logic, large-scale integration, logic arrays logic in memory, push-down memory, sorting, switching functions.



CELL EQUATIONS: $\hat{x} = \overline{w}x + wy$ $s_y = wcx, r_y = wc\overline{x}$ $\hat{z} = M(x, \overline{y}, z) = x\overline{y} + z(x + \overline{y})$

Fig. 1. Cellular sorting array I.

Processing in/near Memory: An Old Idea

Stone, "A Logic-in-Memory Computer," IEEE TC 1970

A Logic-in-Memory Computer

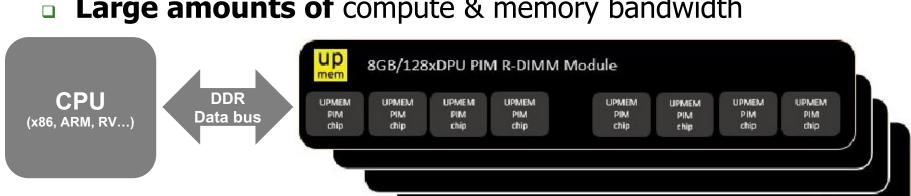
HAROLD S. STONE

Abstract—If, as presently projected, the cost of microelectronic arrays in the future will tend to reflect the number of pins on the array rather than the number of gates, the logic-in-memory array is an extremely attractive computer component. Such an array is essentially a microelectronic memory with some combinational logic associated with each storage element.

UPMEM Processing-in-DRAM Engine (2019)

- Processing in DRAM Engine
- Includes **standard DIMM modules**, with a **large** number of DPU processors combined with DRAM chips.
- Replaces **standard** DIMMs
 - DDR4 R-DIMM modules
 - 8GB+128 DPUs (16 PIM chips)
 - Standard 2x-nm DRAM process







Experimental Analysis of the UPMEM PIM Engine

Benchmarking a New Paradigm: An Experimental Analysis of a Real Processing-in-Memory Architecture

JUAN GÓMEZ-LUNA, ETH Zürich, Switzerland
IZZAT EL HAJJ, American University of Beirut, Lebanon
IVAN FERNANDEZ, ETH Zürich, Switzerland and University of Malaga, Spain
CHRISTINA GIANNOULA, ETH Zürich, Switzerland and NTUA, Greece
GERALDO F. OLIVEIRA, ETH Zürich, Switzerland
ONUR MUTLU, ETH Zürich, Switzerland

Many modern workloads, such as neural networks, databases, and graph processing, are fundamentally memory-bound. For such workloads, the data movement between main memory and CPU cores imposes a significant overhead in terms of both latency and energy. A major reason is that this communication happens through a narrow bus with high latency and limited bandwidth, and the low data reuse in memory-bound workloads is insufficient to amortize the cost of main memory access. Fundamentally addressing this *data movement bottleneck* requires a paradigm where the memory system assumes an active role in computing by integrating processing capabilities. This paradigm is known as *processing-in-memory (PIM)*.

Recent research explores different forms of PIM architectures, motivated by the emergence of new 3D-stacked memory technologies that integrate memory with a logic layer where processing elements can be easily placed. Past works evaluate these architectures in simulation or, at best, with simplified hardware prototypes. In contrast, the UPMEM company has designed and manufactured the first publicly-available real-world PIM architecture. The UPMEM PIM architecture combines traditional DRAM memory arrays with general-purpose in-order cores, called *DRAM Processing Units* (*DPUs*), integrated in the same chip.

This paper provides the first comprehensive analysis of the first publicly-available real-world PIM architecture. We make two key contributions. First, we conduct an experimental characterization of the UPMEM-based PIM system using microbenchmarks to assess various architecture limits such as compute throughput and memory bandwidth, yielding new insights. Second, we present *PrIM* (*Processing-In-Memory benchmarks*), a benchmark suite of 16 workloads from different application domains (e.g., dense/sparse linear algebra, databases, data analytics, graph processing, neural networks, bioinformatics, image processing), which we identify as memory-bound. We evaluate the performance and scaling characteristics of PrIM benchmarks on the UPMEM PIM architecture, and compare their performance and energy consumption to their state-of-the-art CPU and GPU counterparts. Our extensive evaluation conducted on two real UPMEM-based PIM systems with 640 and 2,556 DPUs provides new insights about suitability of different workloads to the PIM system, programming recommendations for software designers, and suggestions and hints for hardware and architecture designers of future PIM systems.

UPMEM PIM System Summary

Juan Gomez-Luna, Izzat El Hajj, Ivan Fernandez, Christina Giannoula, Geraldo F. Oliveira, and Onur Mutlu,

"Benchmarking Memory-Centric Computing Systems: Analysis of Real **Processing-in-Memory Hardware**"

Invited Paper at Workshop on Computing with Unconventional Technologies (CUT), Virtual, October 2021.

[arXiv version]

[PrIM Benchmarks Source Code]

[Slides (pptx) (pdf)]

[Talk Video (37 minutes)]

[Lightning Talk Video (3 minutes)]

Benchmarking Memory-Centric Computing Systems: Analysis of Real Processing-in-Memory Hardware

Juan Gómez-Luna ETH Zürich

Izzat El Haji American University of Beirut

University of Malaga

National Technical University of Athens

Ivan Fernandez Christina Giannoula Geraldo F. Oliveira Onur Mutlu ETH Zürich

ETH Zürich

Understanding a Modern PIM Architecture



Samsung Function-in-Memory DRAM (2021)

Samsung Newsroom

CORPORATE

PRODUCTS

PRESS RESOURCES

VIEWS

ABOUT US

Q

Samsung Develops Industry's First High Bandwidth Memory with AI Processing Power

Korea on February 17, 2021

Audio



Share (5





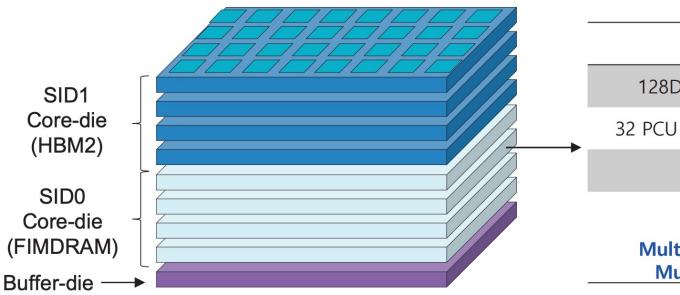
The new architecture will deliver over twice the system performance and reduce energy consumption by more than 70%

Samsung Electronics, the world leader in advanced memory technology, today announced that it has developed the industry's first High Bandwidth Memory (HBM) integrated with artificial intelligence (AI) processing power — the HBM-PIM The new processing-in-memory (PIM) architecture brings powerful AI computing capabilities inside high-performance memory, to accelerate large-scale processing in data centers, high performance computing (HPC) systems and AI-enabled mobile applications.

Kwangil Park, senior vice president of Memory Product Planning at Samsung Electronics stated, "Our groundbreaking HBM-PIM is the industry's first programmable PIM solution tailored for diverse Al-driven workloads such as HPC, training and inference. We plan to build upon this breakthrough by further collaborating with Al solution providers for even more advanced PIM-powered applications."

Samsung Function-in-Memory DRAM (2021)

FIMDRAM based on HBM2



[3D Chip Structure of HBM with FIMDRAM]

Chip Specification

128DQ / 8CH / 16 banks / BL4

32 PCU blocks (1 FIM block/2 banks)

1.2 TFLOPS (4H)

FP16 ADD /
Multiply (MUL) /
Multiply-Accumulate (MAC) /
Multiply-and- Add (MAD)

ISSCC 2021 / SESSION 25 / DRAM / 25.4

25.4 A 20nm 6GB Function-In-Memory DRAM, Based on HBM2 with a 1.2TFLOPS Programmable Computing Unit Using Bank-Level Parallelism. for Machine Learning Applications

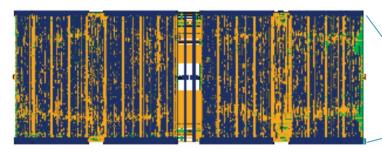
Young-Cheon Kwon', Suk Han Lee', Jaehoon Lee', Sang-Hyuk Kwon', Je Min Ryu', Jong-Pil Son', Seongil O', Hak-Soo Yu', Haesuk Lee', Soo Young Kim', Youngmin Cho', Jin Guk Kim', Jongyoon Choi', Hyun-Sung Shin', Jin Kim', BengSeng Phuah', HyoungMin Kim', Myeong Jun Song', Ahn Choi', Daeho Kim', SooYoung Kim', Eun-Bong Kim', David Wang', Shinhaeng Kang', Yuhwan Ro³, Seungwoo Seo³, JoonHo Song³, Jaeyoun Youn', Kyomin Sohn', Nam Sung Kim'

¹Samsung Electronics, Hwaseong, Korea ²Samsung Electronics, San Jose, CA ³Samsung Electronics, Suwon, Korea

Samsung Function-in-Memory DRAM (2021)

Chip Implementation

- Mixed design methodology to implement FIMDRAM
 - Full-custom + Digital RTL

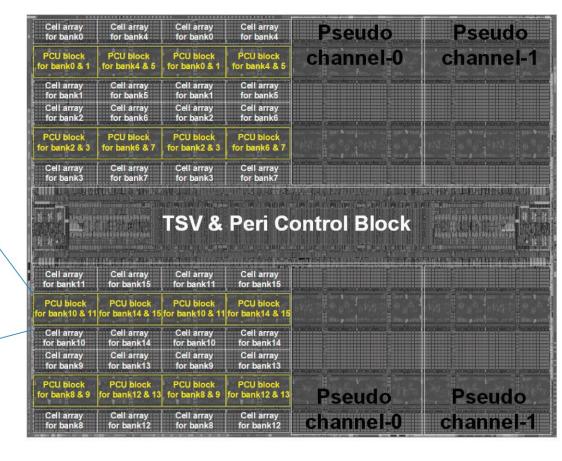


[Digital RTL design for PCU block]

ISSCC 2021 / SESSION 25 / DRAM / 25.4

25.4 A 20nm 6GB Function-In-Memory DRAM, Based on HBM2 with a 1.2TFLOPS Programmable Computing Unit Using Bank-Level Parallelism, for Machine Learning Applications

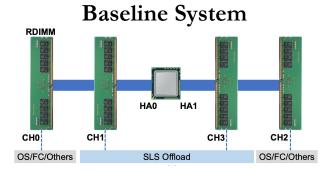
Young-Cheon Kwon', Suk Han Ler', Jaehoon Ler', Sang-Hyuk Kwon', Je Min Ryu', Jong-Pil Son', Seongil O', Hak-Soo Yu', Haesuk Lee', Soo Young Kim', Youngmin Cho', Jin Guk Kim', Jongyoon Choi', Hyun-Sung Shin', Jin Kim', BengSeng Phuah', HyoungMin Kim', Hyeong Jun Song', Am Choi', Deach Kim', Soo'Qung Kim', Eun-Bong Kim', David Wang', Shinhaeng Kang', Yuhwan Ro', Seungwoo Seo', JoonHo Song', Jaeyoun Youn', Kyomin Sohn', Man Sung Kim'



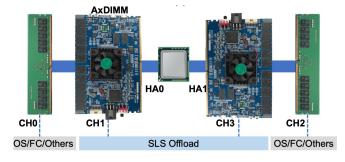
Samsung AxDIMM (2021)

- DIMM-based PIM
 - DLRM recommendation system





AxDIMM System





SK Hynix Accelerator-in-Memory (2022)

SKhynix NEWSROOM

⊕ ENG ∨

INSIGHT

SK hvnix STORY

PRESS CENTER

MULTIMEDIA

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Q

SK hynix Develops PIM, Next-Generation Al Accelerator

February 16, 2022







Seoul, February 16, 2022

SK hynix (or "the Company", www.skhynix.com) announced on February 16 that it has developed PIM*, a nextgeneration memory chip with computing capabilities.

*PIM(Processing In Memory): A next-generation technology that provides a solution for data congestion issues for AI and big data by adding computational functions to semiconductor memory

It has been generally accepted that memory chips store data and CPU or GPU, like human brain, process data. SK hynix, following its challenge to such notion and efforts to pursue innovation in the next-generation smart memory, has found a breakthrough solution with the development of the latest technology.

SK hynix plans to showcase its PIM development at the world's most prestigious semiconductor conference, 2022 ISSCC*, in San Francisco at the end of this month. The company expects continued efforts for innovation of this technology to bring the memory-centric computing, in which semiconductor memory plays a central role, a step closer in Paper 11.1. SK Hynix describes an Tynm, GDDR6-based accelerator-in-memory with a command set for deep-learning operation. The to the reality in devices such as smartphones.

*ISSCC: The International Solid-State Circuits Conference will be held virtually from Feb. 20 to Feb. 24 this year with a theme of "Intelligent Silicon for a Sustainable World'

For the first product that adopts the PIM technology, SK hynix has developed a sample of GDDR6-AiM (Accelerator* in memory). The GDDR6-AiM adds computational functions to GDDR6* memory chips, which process data at 16Gbps. A combination of GDDR6-AiM with CPU or GPU instead of a typical DRAM makes certain computation speed 16 times faster. GDDR6-AiM is widely expected to be adopted for machine learning, high-performance computing, and big data computation and storage



11.1 A 1ynm 1.25V 8Gb, 16Gb/s/pin GDDR6-based Accelerator-in-Memory supporting 1TFLOPS MAC Operation and Various Activation Functions for Deep-Learning Applications

Seongiu Lee, SK hynix, Icheon, Korea

8Gb design achieves a peak throughput of 1TFLOPS with 1GHz MAC operations and supports major activation functions to improve

Key Takeaways

- This P&S is aimed at improving your
 - Knowledge in Computer Architecture and Processing-in-Memory
 - Technical skills in programming parallel (PIM) architectures and CompArch simulation
 - Critical thinking and analysis
 - Interaction with a nice group of researchers
 - Familiarity with key research directions
 - Technical presentation of your project

(Learn how to) overcome the data movement bottleneck by programming, benchmarking, exploring different designs of the PIM computing paradigm

Prerequisites of the Course

- Digital Design and Computer Architecture (or equivalent course)
 - https://safari.ethz.ch/digitaltechnik/spring2021/doku.php?id=schedule
 - https://safari.ethz.ch/digitaltechnik/spring2022/doku.php?id=schedule
- Familiarity with C/C++ programming
 - FPGA implementation or GPU programming (desirable)
- Interest in
 - future computer architectures and computing paradigms
 - discovering why things do or do not work and solving problems
 - making systems efficient and usable

Course Info: Who Are We? (I)

Onur Mutlu

- □ Full Professor @ ETH Zurich ITET (INFK), since September 2015
- Strecker Professor @ Carnegie Mellon University ECE/CS, 2009-2016, 2016-...
- PhD from UT-Austin, worked at Google, VMware, Microsoft Research, Intel, AMD
- https://people.inf.ethz.ch/omutlu/
- omutlu@gmail.com (Best way to reach me)
- https://people.inf.ethz.ch/omutlu/projects.htm

Research and Teaching in:

- Computer architecture, computer systems, hardware security, bioinformatics
- Memory and storage systems
- Hardware security, safety, predictability
- Fault tolerance
- Hardware/software cooperation
- Architectures for bioinformatics, health, medicine
- **...**

Course Info: Who Are We? (II)

- Lead Supervisor:
 - Dr. Juan Gómez Luna



- Dr. Haiyu Mao
- Geraldo F. Oliveira
- Konstantinos Kanellopoulos
- Nika Mansouri Ghiasi











- Get to know us and our research
 - https://safari.ethz.ch/safari-group/

Onur Mutlu's SAFARI Research Group

Computer architecture, HW/SW, systems, bioinformatics, security, memory

https://safari.ethz.ch/safari-newsletter-january-2021/



Think BIG, Aim HIGH!

SAFARI Newsletter December 2021 Edition

https://safari.ethz.ch/safari-newsletter-december-2021/



Think Big, Aim High

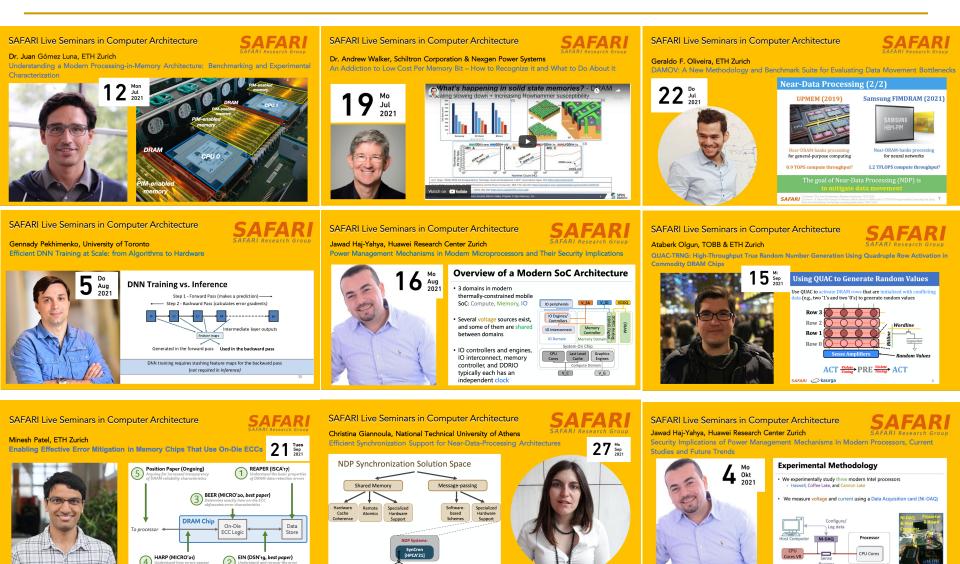




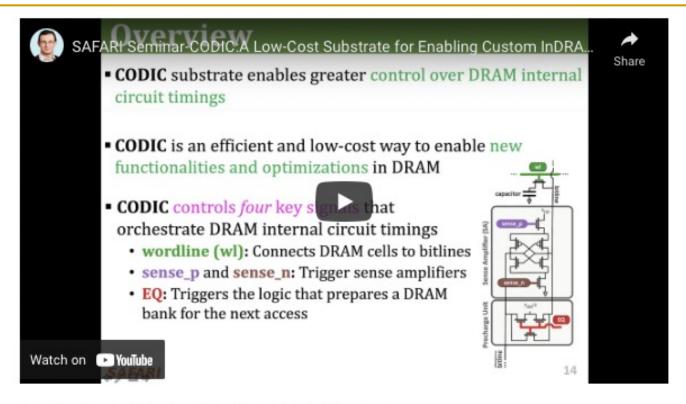
View in your browser December 2021



SAFARI Live Seminars (I)



SAFARI Live Seminars (II)



SAFARI Live Seminar: Lois Orosa, 10 Feb 2022

Posted on January 16, 2022 by ewent

Join us for our next SAFARI Live Seminar with Lois Orosa.

Thursday, February 10 at 5:00 pm Zurich time (CET)

Lois Orosa, SAFARI Research Group, ETH Zurich

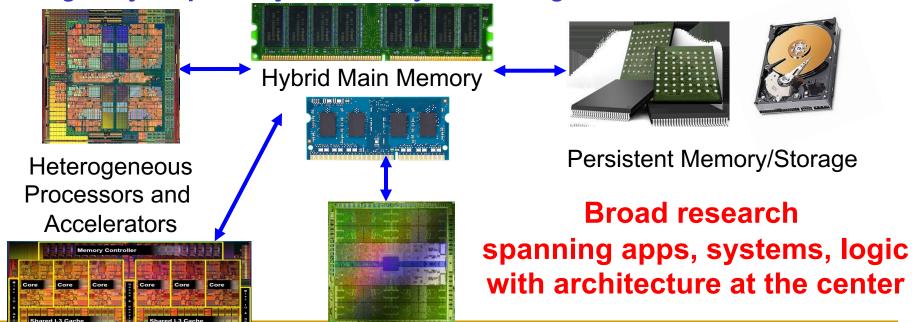
CODIC: A Low-Cost Substrate for Enabling Custom In-DRAM Functionalities and Optimizations

Livestream on YouTube Link

Current Research Focus Areas

Research Focus: Computer architecture, HW/SW, bioinformatics

- Memory and storage (DRAM, flash, emerging), interconnects
- Heterogeneous & parallel systems, GPUs, systems for data analytics
- System/architecture interaction, new execution models, new interfaces
- Energy efficiency, fault tolerance, hardware security, performance
- Genome sequence analysis & assembly algorithms and architectures
- Biologically inspired systems & system design for bio/medicine



Course Info: How About You?

- Let us know your background, interests
- Why did you join this P&S?

Course Requirements and Expectations

- Attendance required for all meetings
- Study the learning materials
- Each student will carry out a hands-on project
 - Build, implement, code, and design with close engagement from the supervisors
- Participation
 - Ask questions, contribute thoughts/ideas
 - Read relevant papers

We will help in all projects!

If your work is really good, you may get it published!

Course Website

- https://safari.ethz.ch/projects_and_seminars/doku.php?id= processing_in_memory
- Useful information about the course
- Check your email frequently for announcements
- We will also have Moodle for Q&A

Meeting 1: Learning Materials

Required materials:

1. Onur Mutlu, Saugata Ghose, Juan Gomez-Luna, and Rachata Ausavarungnirun,

"A Modern Primer on Processing in Memory"

Invited Book Chapter in Emerging Computing: From Devices to Systems - Looking Beyond Moore and Von Neumann, Springer, to be published in 2021.

[Tutorial Video on "Memory-Centric Computing Systems" (1 hour 51 minutes)]

2. Onur Mutlu,

"Memory-Centric Computing"

Education Class at Embedded Systems Week (ESWEEK), Virtual, 9 October 2021.

[Slides (pptx) (pdf)]

[Abstract (pdf)]

[Talk Video (2 hours, including Q&A)]

[Invited Paper at DATE 2021]

["A Modern Primer on Processing in Memory" paper]

Recommended materials:

3. Saugata Ghose, Amirali Boroumand, Jeremie S. Kim, Juan Gomez-Luna, and Onur Mutlu,

"Processing-in-Memory: A Workload-Driven Perspective"

Invited Article in IBM Journal of Research & Development, Special Issue on Hardware for Artificial Intelligence, November/December 2019. [Preliminary arXiv version]

4. Computation in Memory (Professor Onur Mutlu, lecture, Fall 2020).

(PDF) (PPT) Video

5. Near-data Processing (Professor Onur Mutlu, lecture, Fall 2020).

(PDF) (PPT) Video

6. Real Processing-in-DRAM with UPMEM (Dr. Juan Gomez Luna, SAFARI Live Seminar, July 2021).

"Benchmarking a New Paradigm: An Experimental Analysis of a Real Processing-in-Memory Architecture"

Preprint in <u>arXiv</u>, 9 May 2021. [<u>arXiv preprint</u>]

[PrIM Benchmarks Source Code]

[Slides (pptx) (pdf)]

[Long Talk Slides (pptx) (pdf)]

[Short Talk Slides (pptx) (pdf)]

[SAFARI Live Seminar Slides (pptx) (pdf)]

[SAFARI Live Seminar Video (2 hrs 57 mins)]

[<u>Lightning Talk Video</u> (3 minutes)]

Meeting 2 (March 15th)

- We will announce the projects and will give you some description about them
- We will give you a chance to select a project
- Then, we will have 1-1 meetings to match your interests, skills, and background with a suitable project
- It is important that you study the learning materials before our next meeting!

Next Meetings

- Individual meetings with your mentor/s
- Tutorials and short talks
 - PIM programming
 - Recent research works
- Presentation of your work

PIM Course (Fall 2021)

Fall 2021 Edition:

 https://safari.ethz.ch/projects and semi nars/fall2021/doku.php?id=processing in memory

Youtube Livestream:

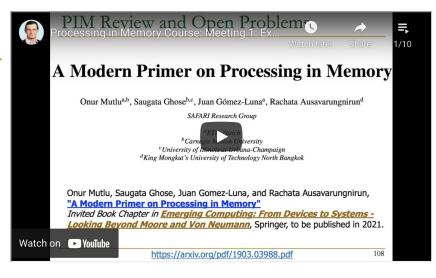
https://www.youtube.com/watch?v=9e4 Chnwdovo&list=PL5Q2soXY2Zi-841fUYYUK9EsXKhQKRPyX

Project course

- Taken by Bachelor's/Master's students
- Processing-in-Memory lectures
- Hands-on research exploration
- Many research readings

Lecture Video Playlist on YouTube

Lecture Playlist



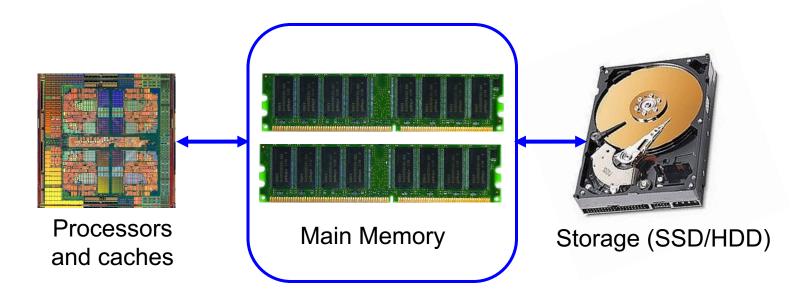
Fall 2021 Meetings/Schedule

Week	Date	Livestream	Meeting	Learning Materials	Assignments
W1	05.10 Tue.	You Tube Live	M1: P&S PIM Course Presentation (PDF) (PPT)	Required Materials Recommended Materials	HW 0 Out
W2	12.10 Tue.	You Tube Live	M2: Real-World PIM Architectures (PDF) (PDF)		
W3	19.10 Tue.	YouTube Live	M3: Real-World PIM Architectures II (PDF) (PDF)		
W4	26.10 Tue.	You Live	M4: Real-World PIM Architectures III (PDF) (PDF)		
W5	02.11 Tue.	YouTube Live	M5: Real-World PIM Architectures IV (PDF) (PDF)		
W6	09.11 Tue.	You Tube Live	M6: End-to-End Framework for Processing-using-Memory (PDF) (PPT)		
W7	16.11 Tue.	You Tube Live	M7: How to Evaluate Data Movement Bottlenecks (PDF) (PPT)		
W8	23.11 Tue.	You Tube Live	M8: Programming PIM Architectures (PDF) (PDF)		
W9	30.11 Tue.	You Tube Live	M9: Benchmarking and Workload Suitability on PIM (PDF) (PPT)		
W10	07.12 Tue.	You Tube Live	M10: Bit-Serial SIMD Processing using DRAM		34

(PDF) (PPT)

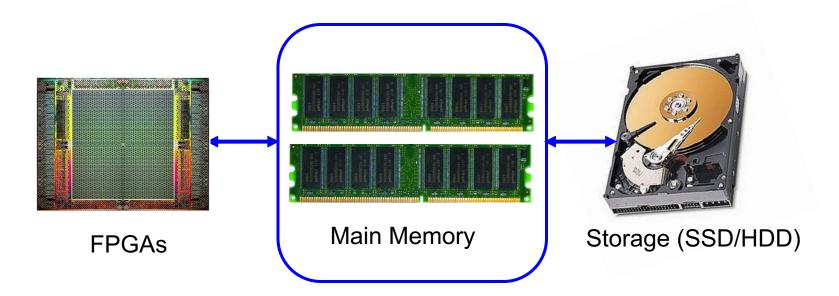
An Introduction to Processing-in-Memory

The Main Memory System



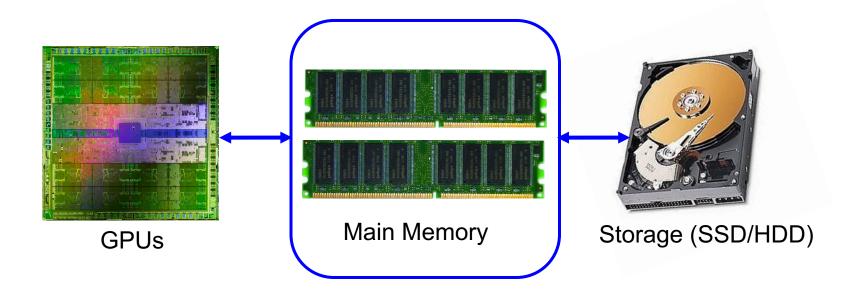
- Main memory is a critical component of all computing systems: server, mobile, embedded, desktop, sensor
- Main memory system must scale (in size, technology, efficiency, cost, and management algorithms) to maintain performance growth and technology scaling benefits

The Main Memory System



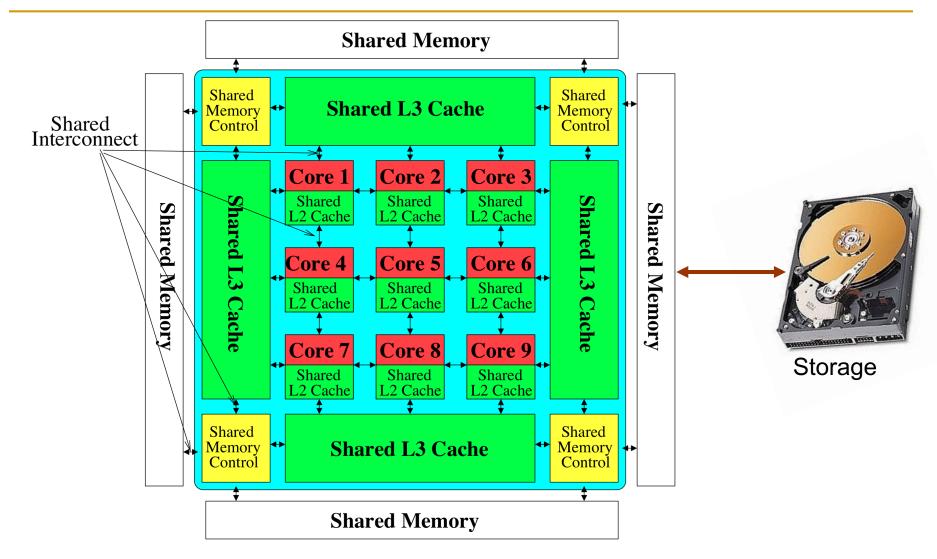
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The Main Memory System



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- Main memory system must scale (in size, technology, efficiency, cost, and management algorithms) to maintain performance growth and technology scaling benefits

Memory System: A Shared Resource View



Most of the system is dedicated to storing and moving data

Three Key Systems Trends

1. Data access is a major bottleneck

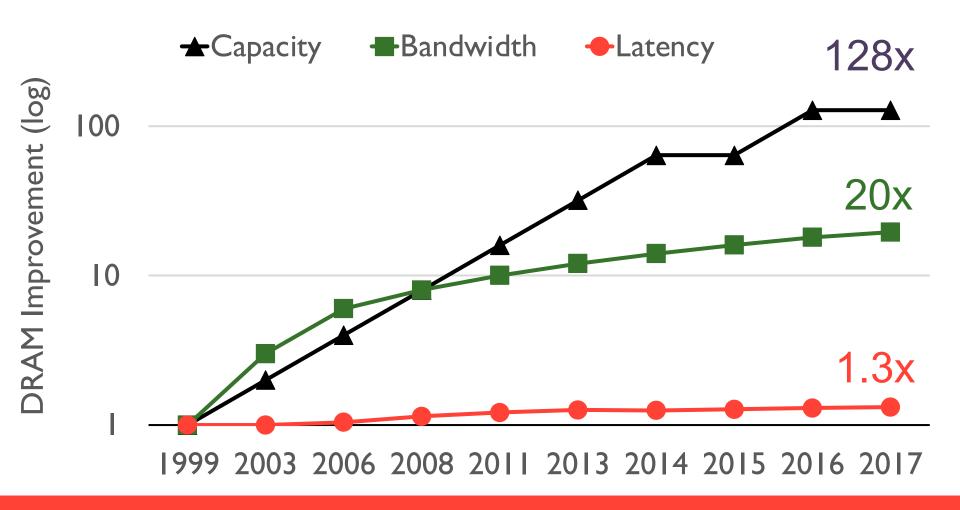
Applications are increasingly data hungry

2. Energy consumption is a key limiter

3. Data movement energy dominates compute

Especially true for off-chip to on-chip movement

Example: Capacity, Bandwidth & Latency



Memory latency remains almost constant

The Need for More Memory Performance



In-memory Databases

[Mao+, EuroSys'12; Clapp+ (Intel), IISWC'15]



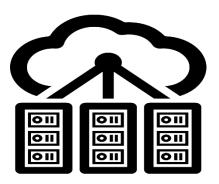
In-Memory Data Analytics

[Clapp+ (Intel), IISWC'15; Awan+, BDCloud'15]



Graph/Tree Processing

[Xu+, IISWC'12; Umuroglu+, FPL'15]



Datacenter Workloads

[Kanev+ (Google), ISCA'15]

DRAM Latency Is Critical for Performance



In-memory Databases



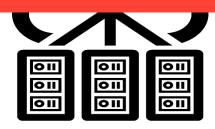
Graph/Tree Processing

Long memory latency → performance bottleneck



In-Memory Data Analytics

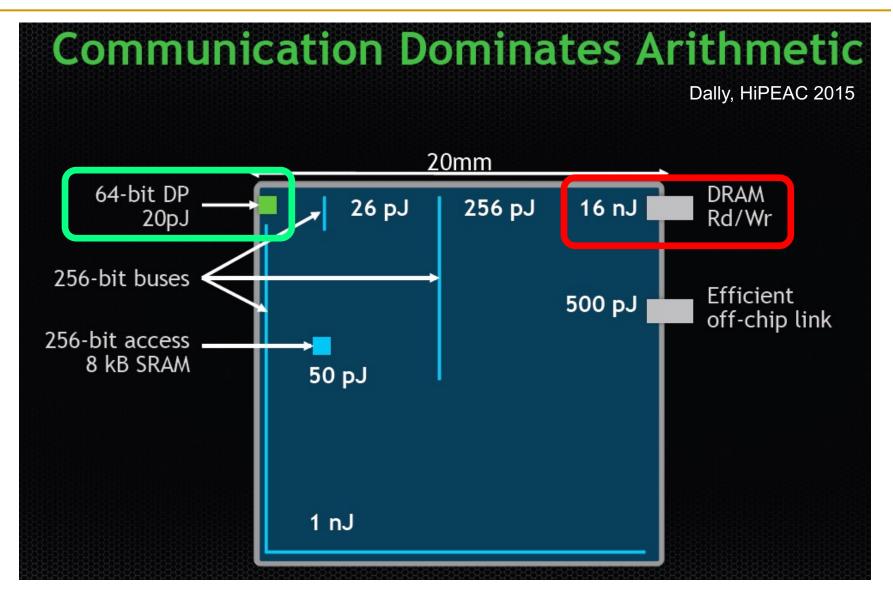
[Clapp+ (Intel), IISWC'15; Awan+, BDCloud'15]



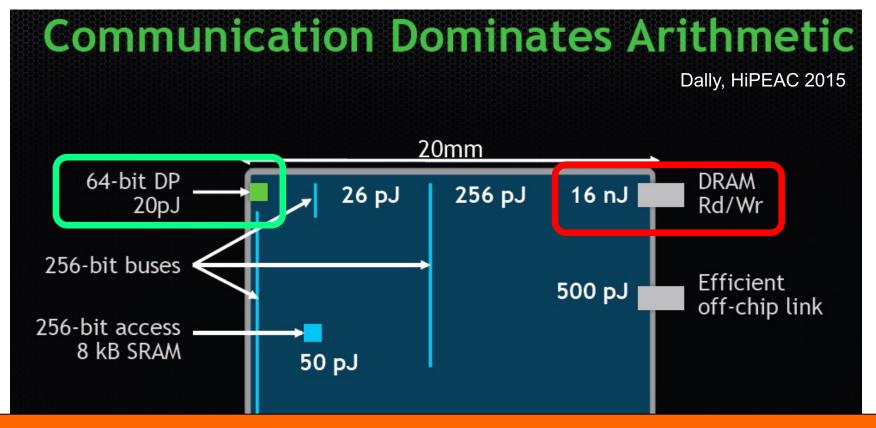
Datacenter Workloads

[Kanev+ (Google), ISCA' 15]

The Energy Perspective



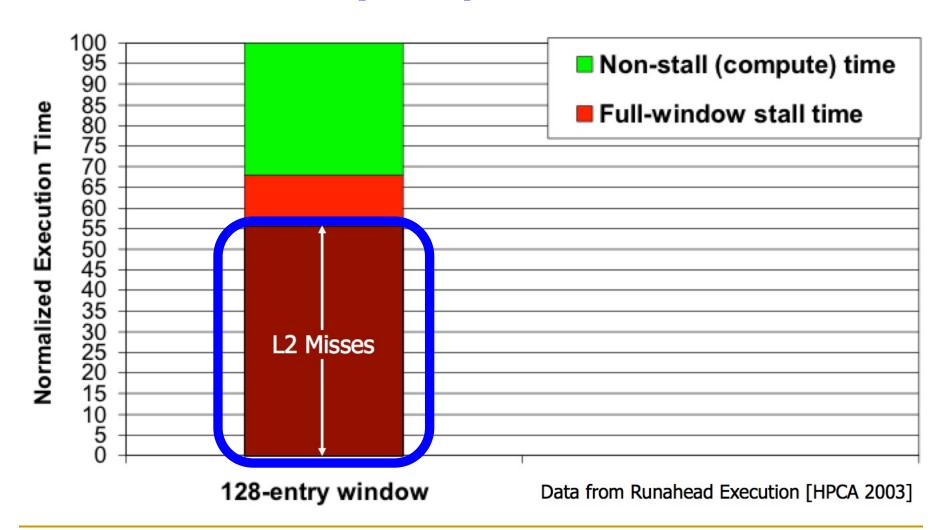
Data Movement vs. Computation Energy



A memory access consumes ~1000X the energy of a complex addition

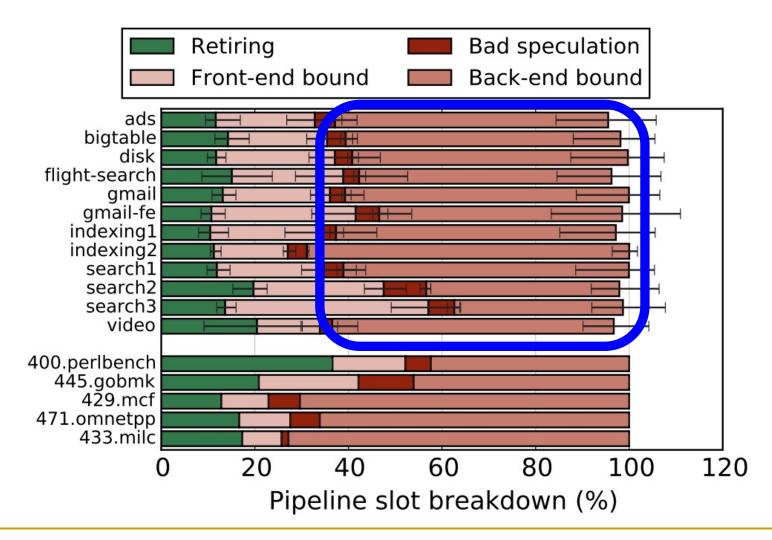
The Performance Perspective (1996-2005)

"It's the Memory, Stupid!" (Richard Sites, MPR, 1996)



The Performance Perspective (Today)

All of Google's Data Center Workloads (2015):



The Problem

Data access is the major performance and energy bottleneck

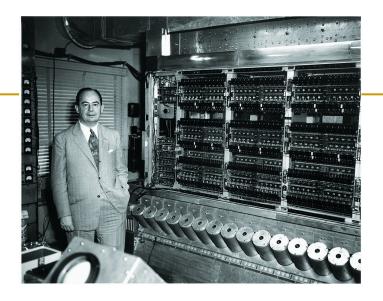
Our current design principles cause great energy waste

(and great performance loss)

Processing of data is performed far away from the data

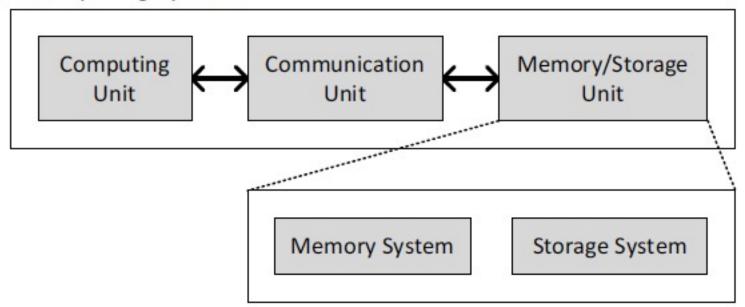
A Computing System

- Three key components
- Computation
- Communication
- Storage/memory



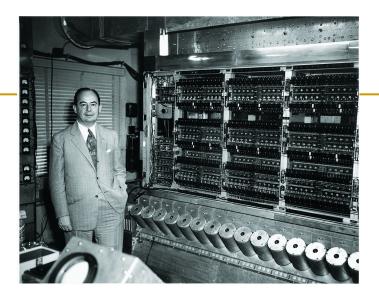
Burks, Goldstein, von Neumann, "Preliminary discussion of the logical design of an electronic computing instrument," 1946.

Computing System



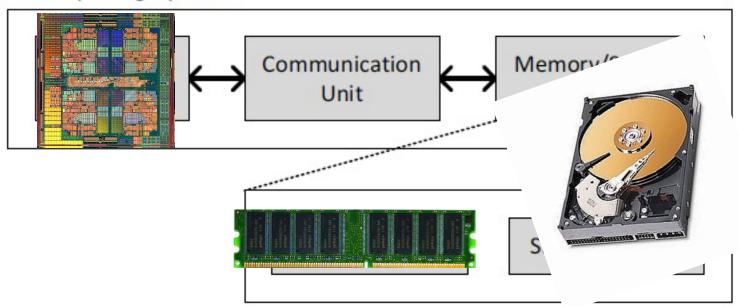
A Computing System

- Three key components
- Computation
- Communication
- Storage/memory



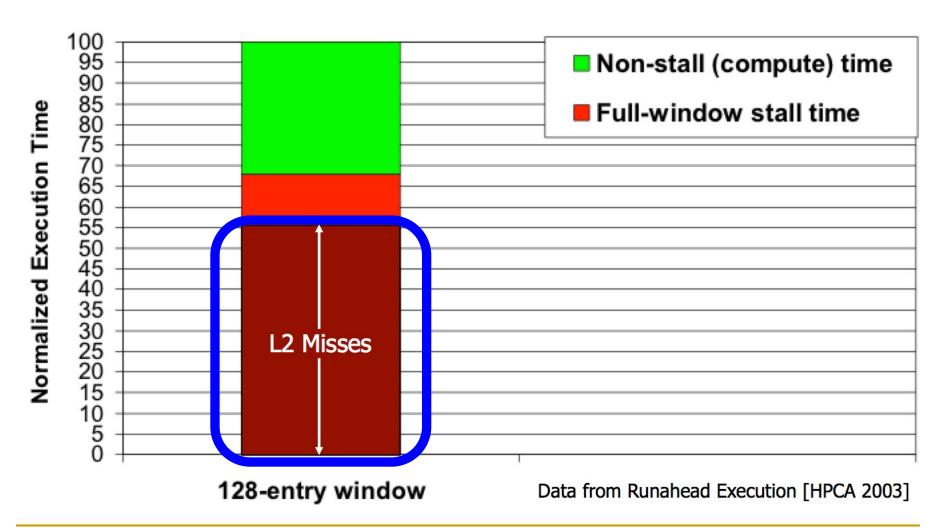
Burks, Goldstein, von Neumann, "Preliminary discussion of the logical design of an electronic computing instrument," 1946.

Computing System



Yet ...

"It's the Memory, Stupid!" (Richard Sites, MPR, 1996)



Perils of Processor-Centric Design

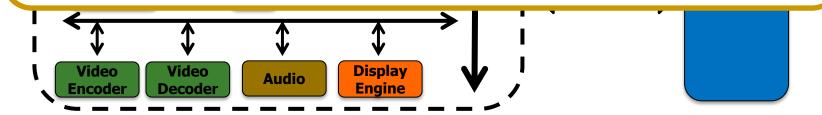
- Grossly-imbalanced systems
 - Processing done only in one place
 - Everything else just stores and moves data: data moves a lot
 - → Energy inefficient
 - → Low performance
 - → Complex
- Overly complex and bloated processor (and accelerators)
 - To tolerate data access from memory
 - Complex hierarchies and mechanisms
 - → Energy inefficient
 - → Low performance
 - → Complex

Data Movement in Computing Systems

- Data movement dominates performance and is a major system energy bottleneck
 - Comprises 41% of mobile system energy during web browsing*

Compute systems should be more data-centric

Processing-In-Memory proposes computing where it makes sense (where data resides)



^{*}Reducing data Movement Energy via Online Data Clustering and Encoding (MICRO'16)

^{**}Quantifying the energy cost of data movement for emerging smart phone workloads on mobile platforms (IISWC'14)

Energy Waste in Mobile Devices

Amirali Boroumand, Saugata Ghose, Youngsok Kim, Rachata Ausavarungnirun, Eric Shiu, Rahul Thakur, Daehyun Kim, Aki Kuusela, Allan Knies, Parthasarathy Ranganathan, and Onur Mutlu, "Google Workloads for Consumer Devices: Mitigating Data Movement Bottlenecks" Proceedings of the 23rd International Conference on Architectural Support for Programming Languages and Operating Systems (ASPLOS), Williamsburg, VA, USA, March 2018.

62.7% of the total system energy is spent on data movement

Google Workloads for Consumer Devices: Mitigating Data Movement Bottlenecks

Amirali Boroumand¹ Rachata Ausavarungnirun¹ Aki Kuusela³ Allan Knies³

Saugata Ghose¹ Youngsok Kim²

Eric Shiu³ Rahul Thakur³ Daehyun Kim^{4,3}

Parthasarathy Ranganathan³ Onur Mutlu^{5,1}

We Need A Paradigm Shift To ...

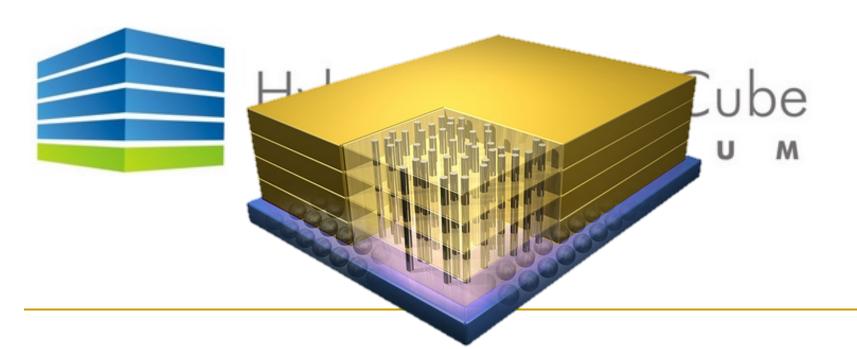
Enable computation with minimal data movement

Compute where it makes sense (where data resides)

Make computing architectures more data-centric

Why In-Memory Computation Today?

- Pull from systems/applications for data-centric execution
- It can be practical today
 - 3D-stacked memories combine logic and memory functionality (relatively) tightly + industry open to new architectures

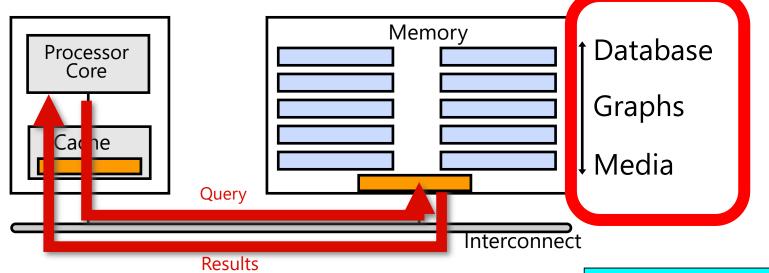


57

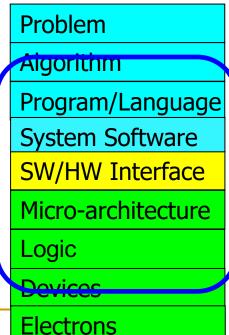
Challenge and Opportunity for Future

High Performance and Energy Efficiency

Goal: Processing Inside Memory

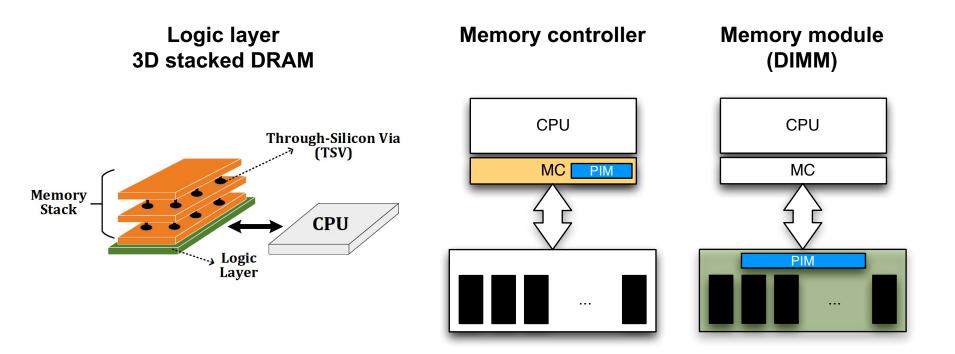


- Many questions... How do we design the:
 - compute-capable memory & controllers?
 - processor chip?
 - software and hardware interfaces?
 - system software and languages?
 - algorithms?



Processing In-Memory (PIM)

- Near-Data Processing or Processing In-Memory (PIM)
 - Move computation closer to where the data resides



UPMEM Processing-in-DRAM Engine (2019)

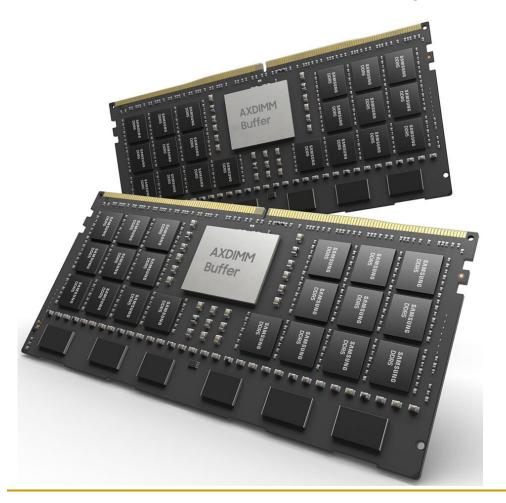
- Processing in DRAM Engine
- Includes standard DIMM modules, with a large number of DPU processors combined with DRAM chips.
- Replaces standard DIMMs
 - DDR4 R-DIMM modules
 - 8GB+128 DPUs (16 PIM chips)
 - Standard 2x-nm DRAM process
 - Large amounts of compute & memory bandwidth

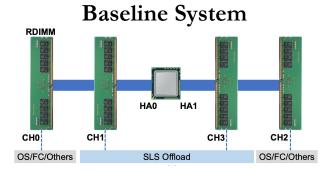




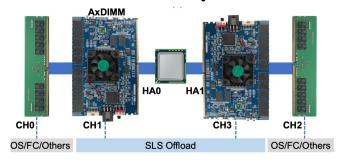
Samsung AxDIMM (2021)

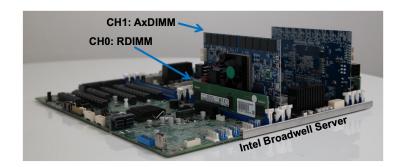
- DIMM-based PIM
 - DLRM recommendation system





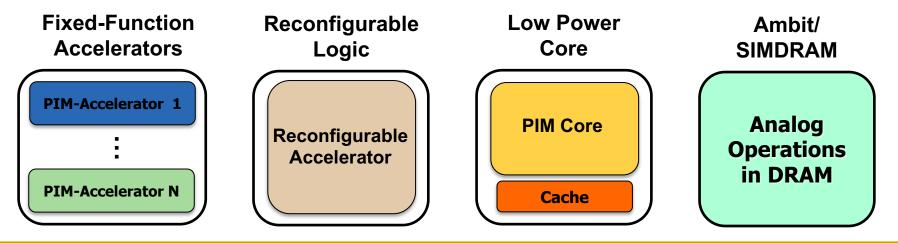
AxDIMM System





Possible Designs

- Fixed-function units
- Reconfigurable architectures
 - FPGAs, CGRA
- General-purpose programmable cores
 - E.g., ARM Cortex R-8, ARM Cortex A-35 (+SIMD units)
 - Possibility of running any workload
- Processing-using-memory:
 - Ambit: In-DRAM bulk bitwise operations (Seshadri+, MICRO'17)
 - SIMDRAM: End-to-end framework for SIMD in DRAM (Hajinazar+, ASPLOS'21)



Two PIM Approaches

5.2. Two Approaches: Processing Using Memory (PUM) vs. Processing Near Memory (PNM)

Many recent works take advantage of the memory technology innovations that we discuss in Section 5.1 to enable and implement PIM. We find that these works generally take one of two approaches, which are categorized in Table 1: (1) processing using memory or (2) processing near memory. We briefly describe each approach here. Sections 6 and 7 will provide example approaches and more detail for both.

Table 1: Summary of enabling technologies for the two approaches to PIM used by recent works. Adapted from [309].

Approach	Enabling Technologies
Processing Using Memory	SRAM
	DRAM Phase-change memory (PCM)
	Magnetic RAM (MRAM)
	Resistive RAM (RRAM)/memristors
Processing Near Memory	Logic layers in 3D-stacked memory
	Silicon interposers
	Logic in memory controllers

Processing using memory (PUM) exploits the existing memory architecture and the operational principles of the memory circuitry to enable operations within main memory with minimal changes. PUM makes use

Onur Mutlu, Saugata Ghose, Juan Gomez-Luna, and Rachata Ausavarungnirun,

"A Modern Primer on Processing in Memory"

Invited Book Chapter in <u>Emerging</u>

<u>Computing: From Devices to Systems - Looking Beyond Moore and Von Neumann</u>,

Springer, to be published in 2021.

[<u>Tutorial Video on "Memory-Centric Computing Systems"</u> (1 hour 51 minutes)]

Processing in Memory: Two Approaches

- 1. Processing-using-Memory
- 2. Processing-near-Memory

Agenda

- Major Trends Affecting Memory
- Processing in Memory: Two Directions
 - Processing-using-Memory (PuM)
 - Minimally Changing Memory Chips
 - Processing-near-Memory (PnM)
 - Exploiting 3D-Stacked Memory

Approach 1: Minimally Changing DRAM

- DRAM has great capability to perform bulk data movement and computation internally with small changes
 - Can exploit internal bandwidth to move data
 - Can exploit analog computation capability
 - **...**
- Examples: RowClone, In-DRAM AND/OR, Gather/Scatter DRAM
 - RowClone: Fast and Efficient In-DRAM Copy and Initialization of Bulk Data (Seshadri et al., MICRO 2013)
 - Fast Bulk Bitwise AND and OR in DRAM (Seshadri et al., IEEE CAL 2015)
 - Gather-Scatter DRAM: In-DRAM Address Translation to Improve the Spatial Locality of Non-unit Strided Accesses (Seshadri et al., MICRO 2015)
 - "Ambit: In-Memory Accelerator for Bulk Bitwise Operations Using Commodity DRAM Technology" (Seshadri et al., MICRO 2017)
 - "SIMDRAM: An End-to-End Framework for Bit-Serial SIMD Computing in DRAM" (Hajinazar et al., ASPLOS 2021)

RowClone: In-Memory Copy and Initialization



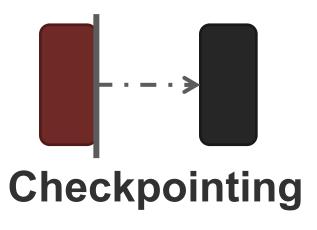
Starting Simple: Data Copy and Initialization

memmove & memcpy: 5% cycles in Google's datacenter [Kanev+ ISCA'15]







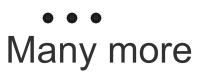




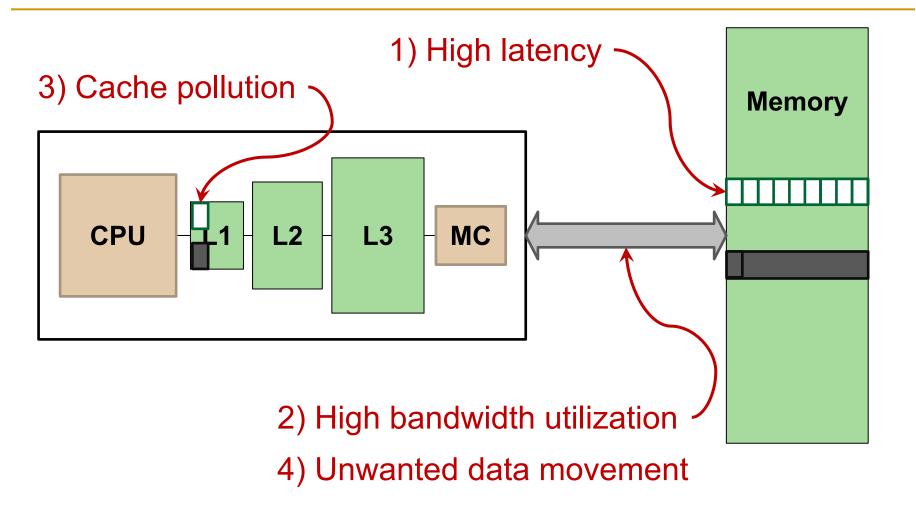




Page Migration

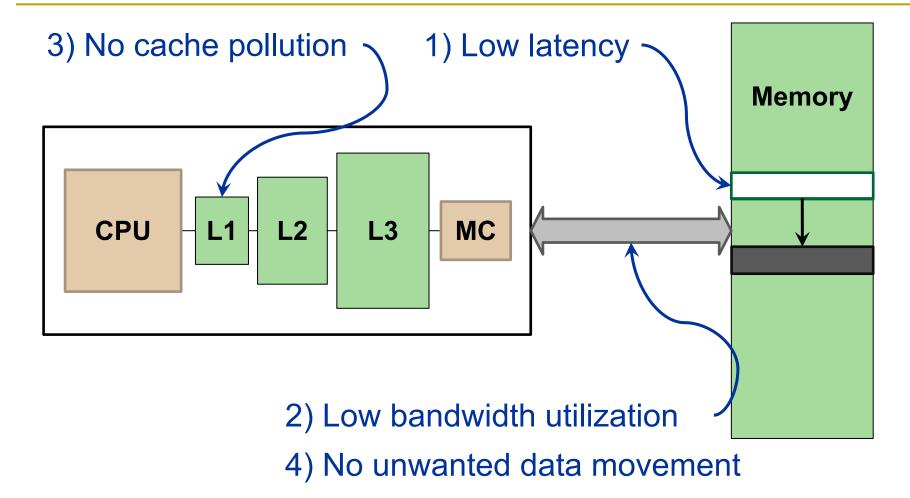


Today's Systems: Bulk Data Copy



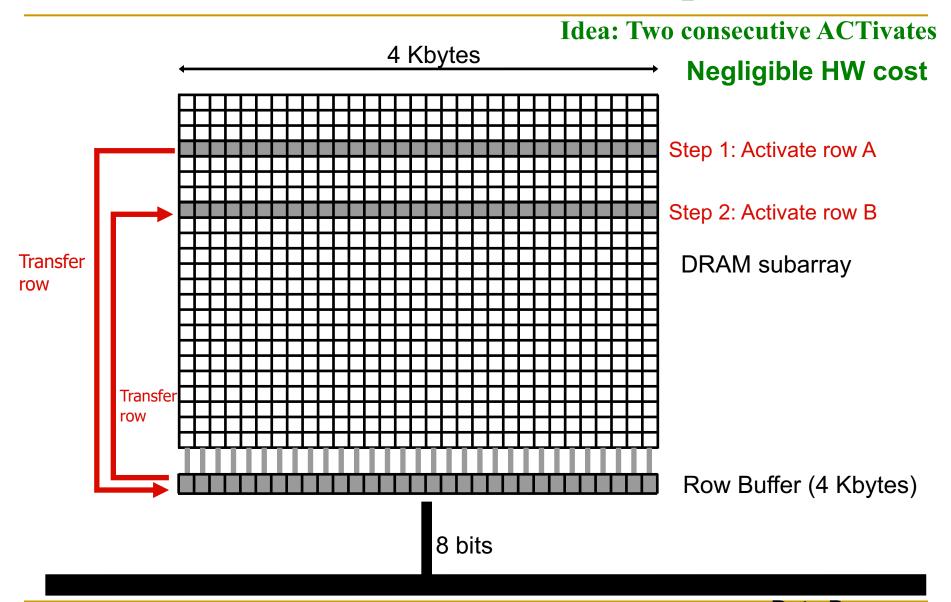
1046ns, 3.6uJ (for 4KB page copy via DMA)

Future Systems: In-Memory Copy

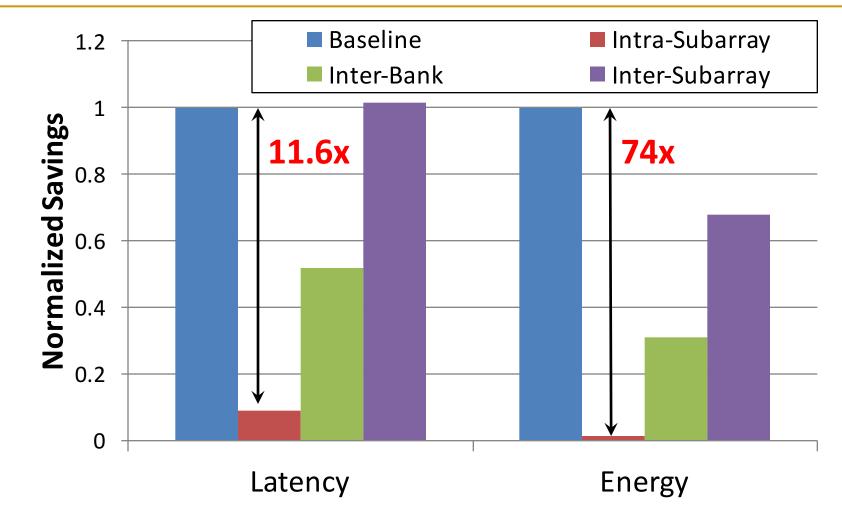


1046ns, 3.6uJ → 90ns, 0.04uJ

RowClone: In-DRAM Row Copy



RowClone: Latency and Energy Savings



Seshadri et al., "RowClone: Fast and Efficient In-DRAM Copy and Initialization of Bulk Data," MICRO 2013.

More on RowClone

Vivek Seshadri, Yoongu Kim, Chris Fallin, Donghyuk Lee, Rachata
 Ausavarungnirun, Gennady Pekhimenko, Yixin Luo, Onur Mutlu, Michael A.
 Kozuch, Phillip B. Gibbons, and Todd C. Mowry,

"RowClone: Fast and Energy-Efficient In-DRAM Bulk Data Copy and Initialization"

Proceedings of the <u>46th International Symposium on Microarchitecture</u> (**MICRO**), Davis, CA, December 2013. [<u>Slides (pptx) (pdf)</u>] [<u>Lightning Session Slides (pptx) (pdf)</u>] [<u>Poster (pptx) (pdf)</u>]

RowClone: Fast and Energy-Efficient In-DRAM Bulk Data Copy and Initialization

Vivek Seshadri Yoongu Kim Chris Fallin* Donghyuk Lee vseshadr@cs.cmu.edu yoongukim@cmu.edu cfallin@c1f.net donghyuk1@cmu.edu

Rachata Ausavarungnirun Gennady Pekhimenko Yixin Luo gpekhime@cs.cmu.edu yixinluo@andrew.cmu.edu

Onur Mutlu Phillip B. Gibbons† Michael A. Kozuch† Todd C. Mowry onur@cmu.edu phillip.b.gibbons@intel.com michael.a.kozuch@intel.com tcm@cs.cmu.edu

Carnegie Mellon University †Intel Pittsburgh

RowClone Demonstration in Real DRAM Chips

ComputeDRAM: In-Memory Compute Using Off-the-Shelf DRAMs

Fei Gao feig@princeton.edu Department of Electrical Engineering Princeton University Georgios Tziantzioulis georgios.tziantzioulis@princeton.edu Department of Electrical Engineering Princeton University David Wentzlaff
wentzlaf@princeton.edu
Department of Electrical Engineering
Princeton University

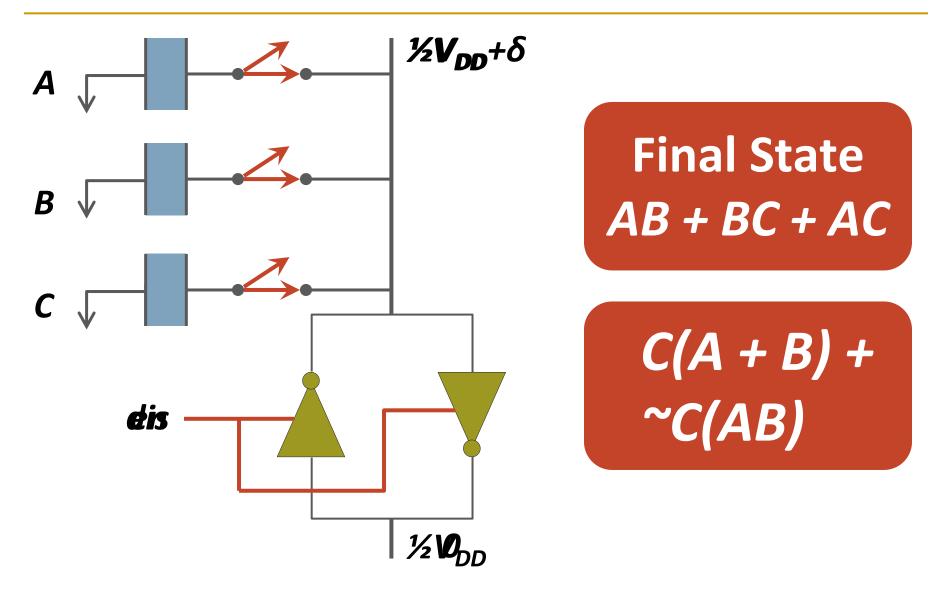
Ambit: In-Memory Bulk Bitwise Operations



In-Memory Bulk Bitwise Operations

- We can support in-DRAM COPY, ZERO, AND, OR, NOT, MAJ
- At low cost
- Using analog computation capability of DRAM
 - Idea: activating multiple rows performs computation
- 30-60X performance and energy improvement
 - Seshadri+, "Ambit: In-Memory Accelerator for Bulk Bitwise Operations Using Commodity DRAM Technology," MICRO 2017.

In-DRAM AND/OR: Triple Row Activation



In-DRAM Bulk Bitwise AND/OR Operation

- BULKAND A, B → C
- Semantics: Perform a bitwise AND of two rows A and B and store the result in row C
- R0 reserved zero row, R1 reserved one row
- D1, D2, D3 Designated rows for triple activation
- 1. RowClone A into D1
- 2. RowClone B into D2
- 3. RowClone R0 into D3
- 4. ACTIVATE D1,D2,D3
- 5. RowClone Result into C

More on In-DRAM Bulk AND/OR

 Vivek Seshadri, Kevin Hsieh, Amirali Boroumand, Donghyuk Lee, Michael A. Kozuch, Onur Mutlu, Phillip B. Gibbons, and Todd C. Mowry,

"Fast Bulk Bitwise AND and OR in DRAM"

IEEE Computer Architecture Letters (CAL), April 2015.

Fast Bulk Bitwise AND and OR in DRAM

Vivek Seshadri*, Kevin Hsieh*, Amirali Boroumand*, Donghyuk Lee*, Michael A. Kozuch[†], Onur Mutlu*, Phillip B. Gibbons[†], Todd C. Mowry*

*Carnegie Mellon University [†]Intel Pittsburgh

In-DRAM NOT: Dual Contact Cell

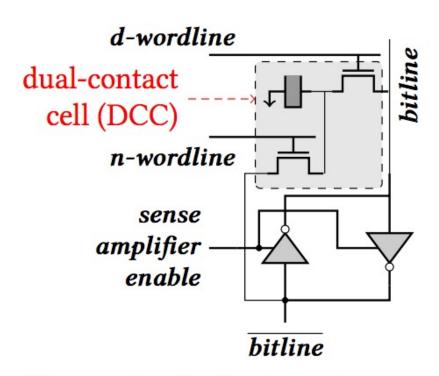


Figure 5: A dual-contact cell connected to both ends of a sense amplifier

Idea:
Feed the
negated value
in the sense amplifier
into a special row

Seshadri+, "Ambit: In-Memory Accelerator for Bulk Bitwise Operations using Commodity DRAM Technology," MICRO 2017

In-DRAM NOT Operation

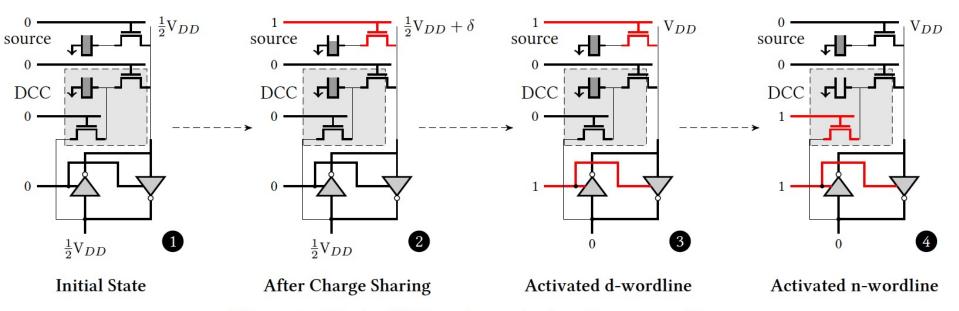


Figure 5: Bitwise NOT using a dual contact capacitor

Seshadri+, "Ambit: In-Memory Accelerator for Bulk Bitwise Operations using Commodity DRAM Technology," MICRO 2017

Performance: In-DRAM Bitwise Operations

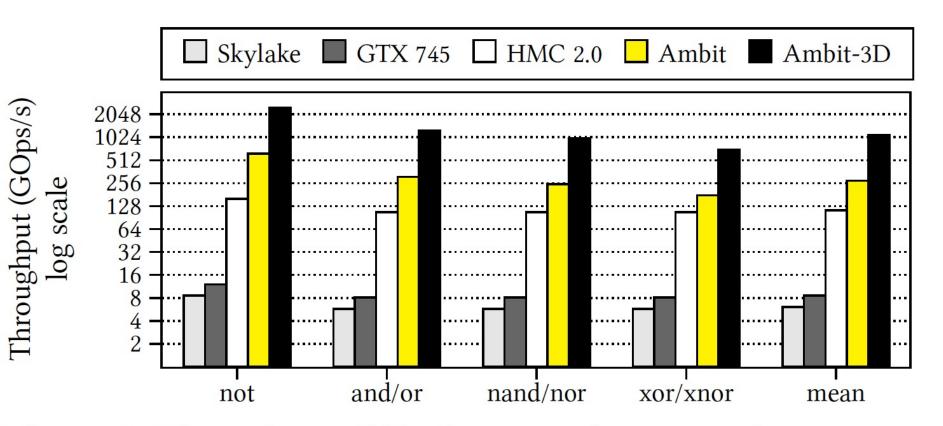


Figure 9: Throughput of bitwise operations on various systems.

Energy of In-DRAM Bitwise Operations

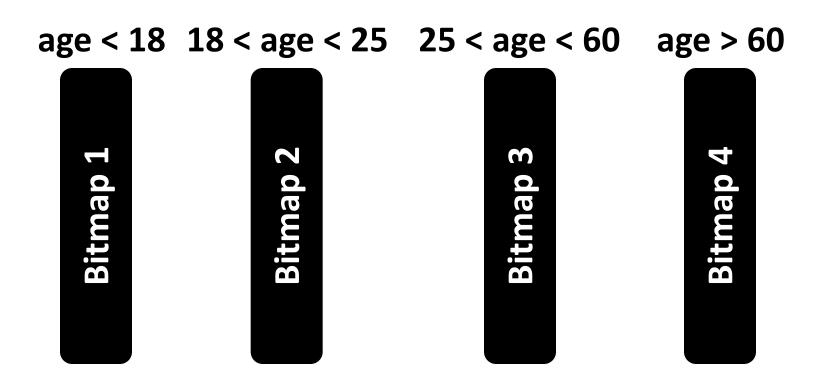
	Design	not	and/or	nand/nor	xor/xnor
DRAM &	DDR3	93.7	137.9	137.9	137.9
Channel Energy	Ambit	1.6	3.2	4.0	5.5
(nJ/KB)	(\downarrow)	59.5X	43.9X	35.1X	25.1X

Table 3: Energy of bitwise operations. (\downarrow) indicates energy reduction of Ambit over the traditional DDR3-based design.

Seshadri+, "Ambit: In-Memory Accelerator for Bulk Bitwise Operations using Commodity DRAM Technology," MICRO 2017

Example Data Structure: Bitmap Index

- Alternative to B-tree and its variants
- Efficient for performing range queries and joins
- Many bitwise operations to perform a query



Performance: Bitmap Index on Ambit

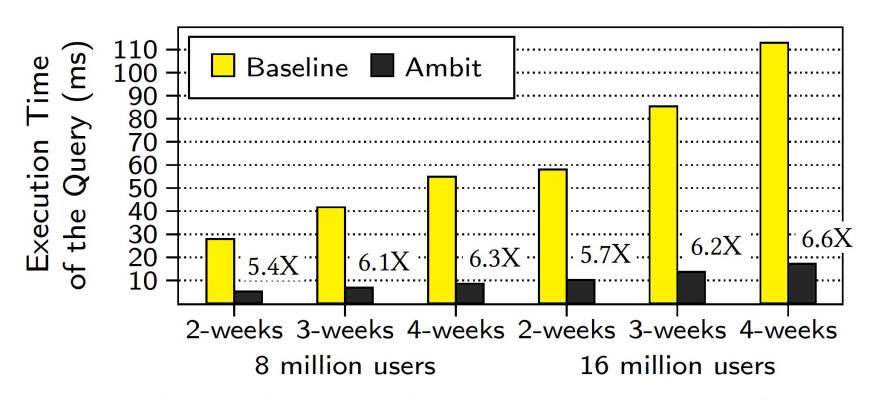


Figure 10: Bitmap index performance. The value above each bar indicates the reduction in execution time due to Ambit.

Seshadri+, "Ambit: In-Memory Accelerator for Bulk Bitwise Operations using Commodity DRAM Technology," MICRO 2017

More on Ambit

 Vivek Seshadri et al., "<u>Ambit: In-Memory Accelerator</u> for Bulk Bitwise Operations Using Commodity DRAM <u>Technology</u>," MICRO 2017.

Ambit: In-Memory Accelerator for Bulk Bitwise Operations
Using Commodity DRAM Technology

Vivek Seshadri 1,5 Donghyuk Lee 2,5 Thomas Mullins 3,5 Hasan Hassan 4 Amirali Boroumand 5 Jeremie Kim 4,5 Michael A. Kozuch 3 Onur Mutlu 4,5 Phillip B. Gibbons 5 Todd C. Mowry 5

 1 Microsoft Research India 2 NVIDIA Research 3 Intel 4 ETH Zürich 5 Carnegie Mellon University

SIMDRAM Framework

Nastaran Hajinazar, Geraldo F. Oliveira, Sven Gregorio, Joao Dinis Ferreira, Nika Mansouri Ghiasi, Minesh Patel, Mohammed Alser, Saugata Ghose, Juan Gomez-Luna, and Onur Mutlu, "SIMDRAM: An End-to-End Framework for Bit-Serial SIMD Computing in DRAM" Proceedings of the 26th International Conference on Architectural Support for Programming Languages and Operating Systems (ASPLOS), Virtual, March-April 2021.

[2-page Extended Abstract]

[Short Talk Slides (pptx) (pdf)]

[Talk Slides (pptx) (pdf)]

[Short Talk Video (5 mins)]

[Full Talk Video (27 mins)]

SIMDRAM: A Framework for Bit-Serial SIMD Processing using DRAM

*Nastaran Hajinazar^{1,2} Nika Mansouri Ghiasi¹ *Geraldo F. Oliveira¹
Minesh Patel¹
Juan Gómez-Luna¹

Sven Gregorio¹ Mohammed Alser¹ Onur Mutlu¹

João Dinis Ferreira¹ Saugata Ghose³

¹ETH Zürich

²Simon Fraser University

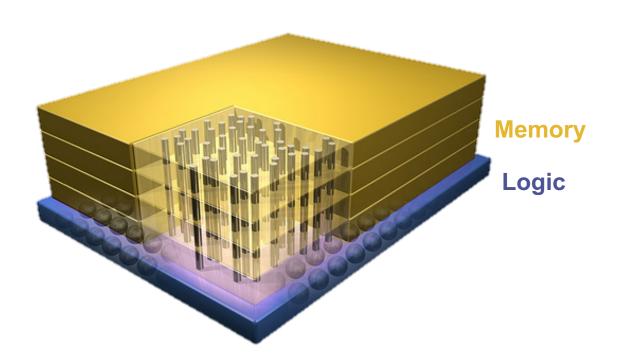
³University of Illinois at Urbana–Champaign

Agenda

- Major Trends Affecting Memory
- Processing in Memory: Two Directions
 - Processing-using-Memory (PuM)
 - Minimally Changing Memory Chips
 - Processing-near-Memory (PnM)
 - Exploiting 3D-Stacked Memory

Approach 2: 3D-Stacked Logic+Memory





Graph Processing

Large graphs are everywhere (circa 2015)



36 Million Wikipedia Pages



1.4 Billion Facebook Users

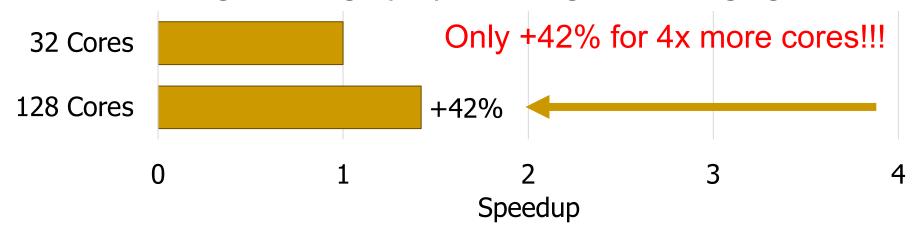


300 Million Twitter Users



30 Billion Instagram Photos

Scalable large-scale graph processing is challenging



Key Bottlenecks in Graph Processing

```
PageRank algorithm (Page et al. 1999)
   for (v: graph.vertices) {
     for (w: v.successors) {
       w.next rank += weight * v.rank;
                        1. Frequent random memory accesses
                                     &w
 w.rank
w.next rank
                                weight * v.rank
 w.edges
            W
                               2. Little amount of computation
```

Two Key Questions in 3D-Stacked PIM

- How can we accelerate important applications if we use 3D-stacked memory as a coarse-grained accelerator?
 - what is the architecture and programming model?
 - what are the mechanisms for acceleration?

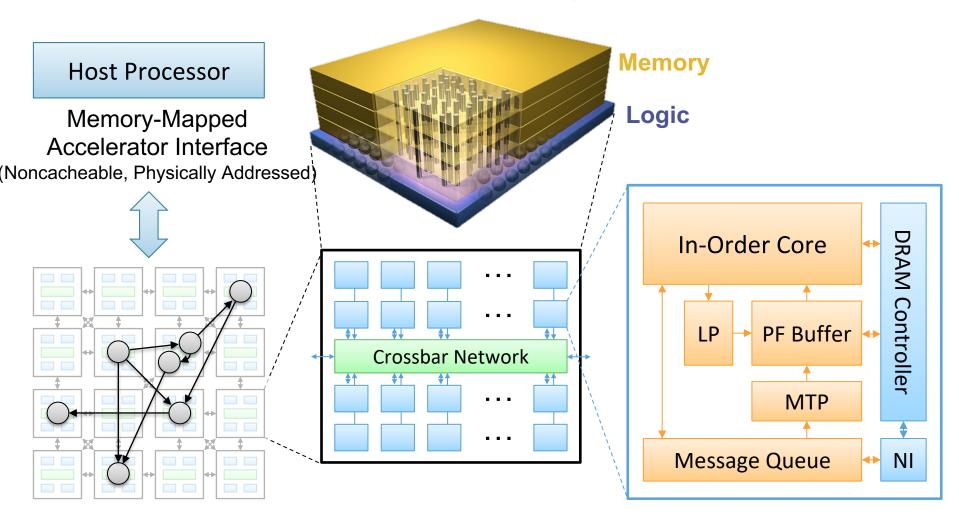
- What is the minimal processing-in-memory support we can provide?
 - without changing the system significantly
 - while achieving significant benefits

Tesseract: An In-Memory Accelerator for Graph Processing



Tesseract System for Graph Processing

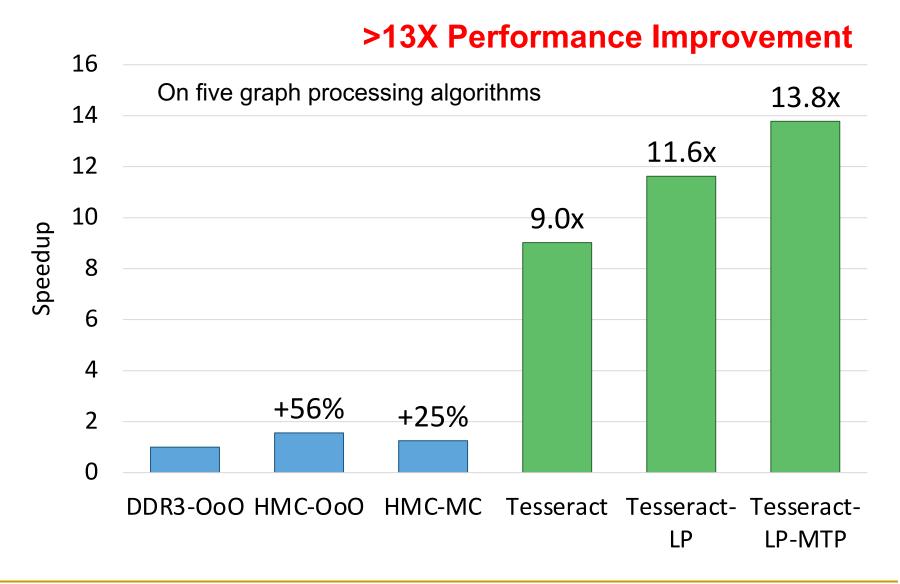
Interconnected set of 3D-stacked memory+logic chips with simple cores



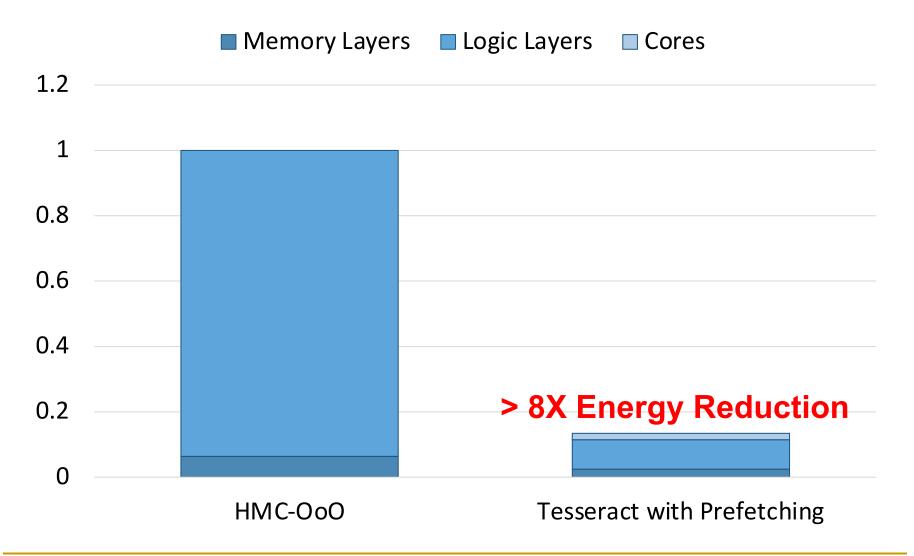
Tesseract System for Graph Processing

- Evaluation on
 - DDR3 DRAM, computation on Out-of-Order (OoO) core
 - Hybrid Memory Cube (HMC) DRAM, computation on Out-of-Order (OoO) core
 - HMC DRAM, computation on the Memory Controller (MC)
 - Tesseract
 - With or without List Prefetching (LP)
 - With or without Message Triggered Prefetching (MTP), specified by the programmer

Tesseract Graph Processing Performance



Tesseract Graph Processing System Energy



More on Tesseract

 Junwhan Ahn, Sungpack Hong, Sungjoo Yoo, Onur Mutlu, and Kiyoung Choi,

"A Scalable Processing-in-Memory Accelerator for Parallel Graph Processing"

Proceedings of the <u>42nd International Symposium on</u> <u>Computer Architecture</u> (**ISCA**), Portland, OR, June 2015. [Slides (pdf)] [Lightning Session Slides (pdf)]

A Scalable Processing-in-Memory Accelerator for Parallel Graph Processing

Junwhan Ahn Sungpack Hong[§] Sungjoo Yoo Onur Mutlu[†] Kiyoung Choi junwhan@snu.ac.kr, sungpack.hong@oracle.com, sungjoo.yoo@gmail.com, onur@cmu.edu, kchoi@snu.ac.kr Seoul National University [§]Oracle Labs [†]Carnegie Mellon University

Two Key Questions in 3D-Stacked PIM

- How can we accelerate important applications if we use 3D-stacked memory as a coarse-grained accelerator?
 - what is the architecture and programming model?
 - what are the mechanisms for acceleration?

- What is the minimal processing-in-memory support we can provide?
 - without changing the system significantly
 - while achieving significant benefits

PIM-Enabled Instructions for Graph Processing



Simple PIM Operations as ISA Extensions (I)

```
PageRank algorithm (Page et al. 1999)
for (v: graph.vertices) {
  value = weight * v.rank;
  for (w: v.successors) {
    w.next rank += value;
                                             Main Memory
      Host Processor
                                              w.next rank
        w.next rank
                           64 bytes in
                          64 bytes out
```

Conventional Architecture

Simple PIM Operations as ISA Extensions (II)

```
PageRank algorithm (Page et al. 1999)
for (v: graph.vertices) {
  value = weight * v.rank;
                                                   pim.add r1, (r2)
  for (w: v.successors) {
       pim_add(&w.next_rank, value);
                                             Main Memory
      Host Processor
                                               w.next rank
           value
                            8 bytes in
                           0 bytes out
```

In-Memory Addition

PEI: Benchmarks

Graph processing

- Average Teenage Follower (AT)
- Breadth-First Search (BFS)
- PageRank (PR)
- Single-Source Shortest Path (SP)
- Weakly Connected Components (WCC)
- Other benchmarks that can benefit from PEI
 - Data analytics
 - Hash Join (HJ)
 - Histogram (HG)
 - Radix Partitioning (RP)
 - Machine learning and data mining
 - Streamcluster (SC)
 - Support Vector Machine (SVM)

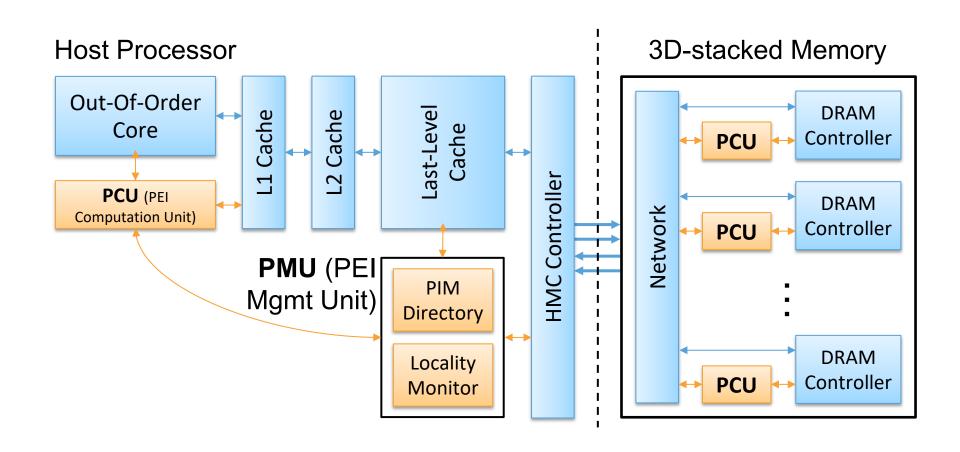
PEI: PIM-Enabled Instructions: Examples

Table 1: Summary of Supported PIM Operations

Operation	R	W	Input	Output	Applications
8-byte integer increment	O	O	0 bytes	0 bytes	AT
8-byte integer min	O	O	8 bytes	0 bytes	BFS, SP, WCC
Floating-point add	O	O	8 bytes	0 bytes	PR
Hash table probing	O	X	8 bytes	9 bytes	HJ
Histogram bin index	O	X	1 byte	16 bytes	HG, RP
Euclidean distance	O	X	64 bytes	4 bytes	SC
Dot product	O	X	32 bytes	8 bytes	SVM

- Executed either in memory or in the processor: dynamic decision
 - Low-cost locality monitoring for a single instruction
- Cache-coherent, virtually-addressed, single cache block only
- Atomic between different PEIs
- Not atomic with normal instructions (use pfence for ordering)

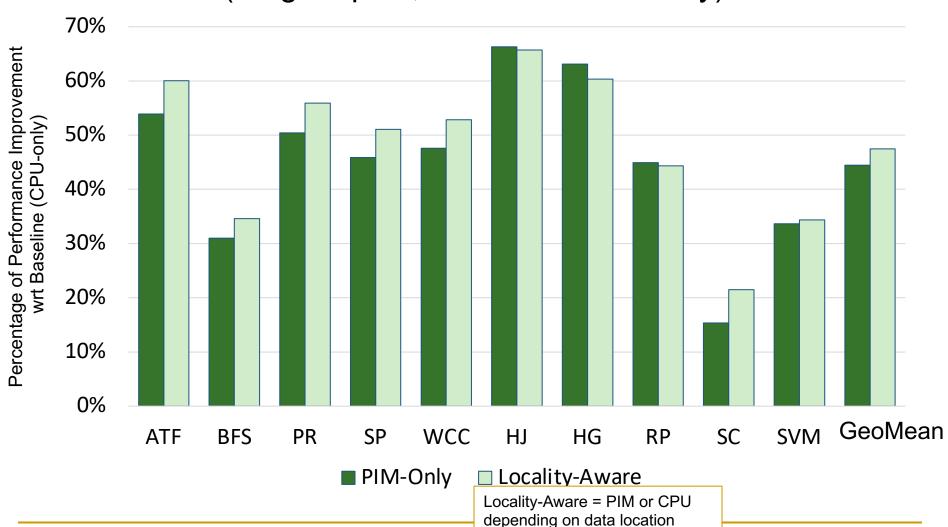
Example PEI Microarchitecture



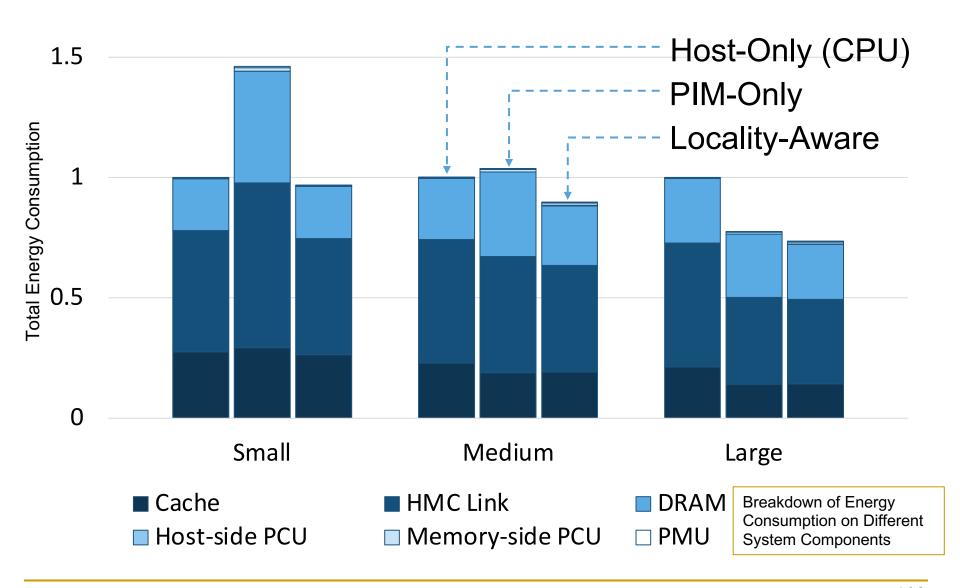
Example PEI uArchitecture

PEI Performance Delta: Large Data Sets





PEI Energy Consumption



More on PIM-Enabled Instructions

Junwhan Ahn, Sungjoo Yoo, Onur Mutlu, and Kiyoung Choi,
 "PIM-Enabled Instructions: A Low-Overhead,
 Locality-Aware Processing-in-Memory Architecture"
 Proceedings of the <u>42nd International Symposium on</u>
 Computer Architecture (ISCA), Portland, OR, June 2015.
 [Slides (pdf)] [Lightning Session Slides (pdf)]

PIM-Enabled Instructions: A Low-Overhead, Locality-Aware Processing-in-Memory Architecture

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Agenda

- Major Trends Affecting Memory
- Processing in Memory: Two Directions
 - Processing-using-Memory (PuM)
 - Minimally Changing Memory Chips
 - Processing-near-Memory (PnM)
 - Exploiting 3D-Stacked Memory

Eliminating the Adoption Barriers

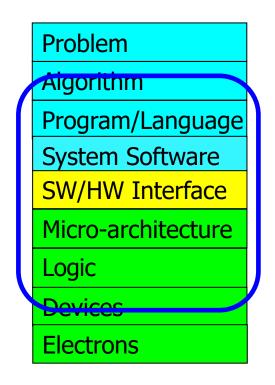
How to Enable Adoption of Processing in Memory

Barriers to Adoption of PIM

- 1. Functionality of and applications & software for PIM
- 2. Ease of programming (interfaces and compiler/HW support)
- 3. System support: coherence & virtual memory
- 4. Runtime and compilation systems for adaptive scheduling, data mapping, access/sharing control
- 5. Infrastructures to assess benefits and feasibility

All can be solved with change of mindset

We Need to Revisit the Entire Stack



We can get there step by step

PIM Review and Open Problems

A Modern Primer on Processing in Memory

Onur Mutlu^{a,b}, Saugata Ghose^{b,c}, Juan Gómez-Luna^a, Rachata Ausavarungnirun^d

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Onur Mutlu, Saugata Ghose, Juan Gomez-Luna, and Rachata Ausavarungnirun,

"A Modern Primer on Processing in Memory"

Invited Book Chapter in <u>Emerging Computing: From Devices to Systems -</u>

Looking Beyond Moore and Von Neumann, Springer, to be published in 2021.

A Modern Primer on Processing in Memory

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Abstract

Modern computing systems are overwhelmingly designed to move data to computation. This design choice goes directly against at least three key trends in computing that cause performance, scalability and energy bottlenecks: (1) data access is a key bottleneck as many important applications are increasingly data-intensive, and memory bandwidth and energy do not scale well, (2) energy consumption is a key limiter in almost all computing platforms, especially server and mobile systems, (3) data movement, especially off-chip to on-chip, is very expensive in terms of bandwidth, energy and latency, much more so than computation. These trends are especially severely-felt in the data-intensive server and energy-constrained mobile systems of today.

At the same time, conventional memory technology is facing many technology scaling challenges in terms of reliability, energy, and performance. As a result, memory system architects are open to organizing memory in different ways and making it more intelligent, at the expense of higher cost. The emergence of 3D-stacked memory plus logic, the adoption of error correcting codes inside the latest DRAM chips, proliferation of different main memory standards and chips, specialized for different purposes (e.g., graphics, low-power, high bandwidth, low latency), and the necessity of designing new solutions to serious reliability and security issues, such as the RowHammer phenomenon, are an evidence of this trend.

This chapter discusses recent research that aims to practically enable computation close to data, an approach we call processing-in-memory (PIM). PIM places computation mechanisms in or near where the data is stored (i.e., inside the memory chips, in the logic layer of 3D-stacked memory, or in the memory controllers), so that data movement between the computation units and memory is reduced or eliminated. While the general idea of PIM is not new, we discuss motivating trends in applications as well as memory circuits/technology that greatly exacerbate the need for enabling it in modern computing systems. We examine at least two promising new approaches to designing PIM systems to accelerate important data-intensive applications: (1) processing using memory by exploiting analog operational properties of DRAM chips to perform massively-parallel operations in memory, with low-cost changes, (2) processing near memory by exploiting 3D-stacked memory technology design to provide high memory bandwidth and low memory latency to in-memory logic. In both approaches, we describe and tackle relevant cross-layer research, design, and adoption challenges in devices, architecture, systems, and programming models. Our focus is on the development of in-memory processing designs that can be adopted in real computing platforms at low cost. We conclude by discussing work on solving key challenges to the practical adoption of PIM.

Keywords: memory systems, data movement, main memory, processing-in-memory, near-data processing, computation-in-memory, processing using memory, processing near memory, 3D-stacked memory, non-volatile memory, energy efficiency, high-performance computing, computer architecture, computing paradigm, emerging technologies, memory scaling, technology scaling, dependable systems, robust systems, hardware security, system security, latency, low-latency computing

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1	Introduction	2
2	Major Trends Affecting Main Memory	4
3	The Need for Intelligent Memory Controllers	
3	to Enhance Memory Scaling	6
	to Emiliance Memory Scaring	U
4	Perils of Processor-Centric Design	9
5	Processing-in-Memory (PIM): Technology	
	Enablers and Two Approaches	12
	5.1 New Technology Enablers: 3D-Stacked	
	Memory and Non-Volatile Memory	12
	5.2 Two Approaches: Processing Using	
	Memory (PUM) vs. Processing Near	
	Memory (PNM)	13
6	Processing Using Memory (PUM)	14
•	6.1 RowClone	14
	6.2 Ambit	15
	6.3 Gather-Scatter DRAM	17
	6.4 In-DRAM Security Primitives	17
		-,
7	Processing Near Memory (PNM)	18
	7.1 Tesseract: Coarse-Grained Application-	
	Level PNM Acceleration of Graph Pro-	
	cessing	19
	7.2 Function-Level PNM Acceleration of	
	Mobile Consumer Workloads	20
	7.3 Programmer-Transparent Function-	
	Level PNM Acceleration of GPU	
	Applications	21
	7.4 Instruction-Level PNM Acceleration	21
	with PIM-Enabled Instructions (PEI)	21
	7.5 Function-Level PNM Acceleration of	22
	Genome Analysis Workloads	22
	Time Series Analysis	23
	Time Series Analysis	23
8	Enabling the Adoption of PIM	24
	8.1 Programming Models and Code Genera-	
	tion for PIM	24
	8.2 PIM Runtime: Scheduling and Data	
	Mapping	25
	8.3 Memory Coherence	27
	8.4 Virtual Memory Support	27
	8.5 Data Structures for PIM	28
	8.6 Benchmarks and Simulation Infrastruc-	
	tures	29
	8.7 Real PIM Hardware Systems and Proto-	
	types	30
	8.8 Security Considerations	30
•	Control of the Control	21
9	Conclusion and Future Outlook	31

1. Introduction

Main memory, built using the Dynamic Random Access Memory (DRAM) technology, is a major component in nearly all computing systems, including servers, cloud platforms, mobile/embedded devices, and sensor systems. Across all of these systems, the data working set sizes of modern applications are rapidly growing, while the need for fast analysis of such data is increasing. Thus, main memory is becoming an increasingly significant bottleneck across a wide variety of computing systems and applications [1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16]. Alleviating the main memory bottleneck requires the memory capacity, energy, cost, and performance to all scale in an efficient manner across technology generations. Unfortunately, it has become increasingly difficult in recent years, especially the past decade, to scale all of these dimensions [1, 2, 17, 18, 19, 20, 21, 22, 23, 24, 25, 26, 27, 28, 29, 30, 31, 32, 33, 34, 35, 36, 37, 38, 39, 40, 41, 42, 43, 44, 45, 46, 47, 48, 49], and thus the main memory bottleneck has been worsening.

A major reason for the main memory bottleneck is the high energy and latency cost associated with data movement. In modern computers, to perform any operation on data that resides in main memory, the processor must retrieve the data from main memory. This requires the memory controller to issue commands to a DRAM module across a relatively slow and power-hungry off-chip bus (known as the memory channel). The DRAM module sends the requested data across the memory channel, after which the data is placed in the caches and registers. The CPU can perform computation on the data once the data is in its registers. Data movement from the DRAM to the CPU incurs long latency and consumes a significant amount of energy [7, 50, 51, 52, 53, 54]. These costs are often exacerbated by the fact that much of the data brought into the caches is not reused by the CPU [52, 53, 55, 56], providing little benefit in return for the high latency and energy cost.

The cost of data movement is a fundamental issue with the *processor-centric* nature of contemporary computer systems. The CPU is considered to be the master in the system, and computation is performed only in the processor (and accelerators). In contrast, data storage and communication units, including the main memory, are treated as unintelligent workers that are incapable of computation. As a result of this processor-centric design paradigm, data moves a lot in the system between the computation units and communication/ storage units so that computation can be done on it. With the increasingly *data-centric* nature of contemporary and emerging appli-

P&S Processing-in-Memory

Exploring the Processing-in-Memory Paradigm for Future Computing Systems

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